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FIG. 1

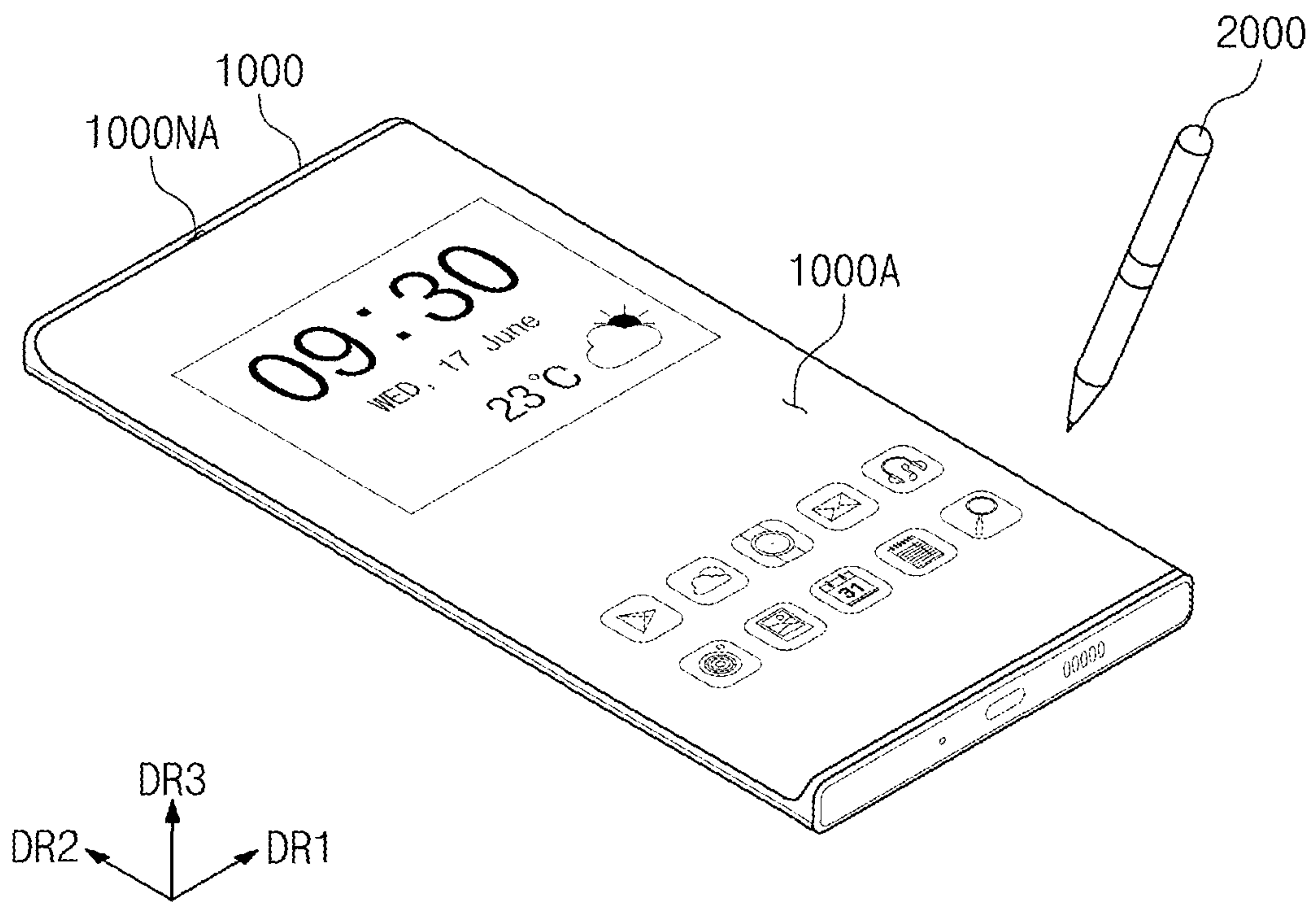


FIG. 2

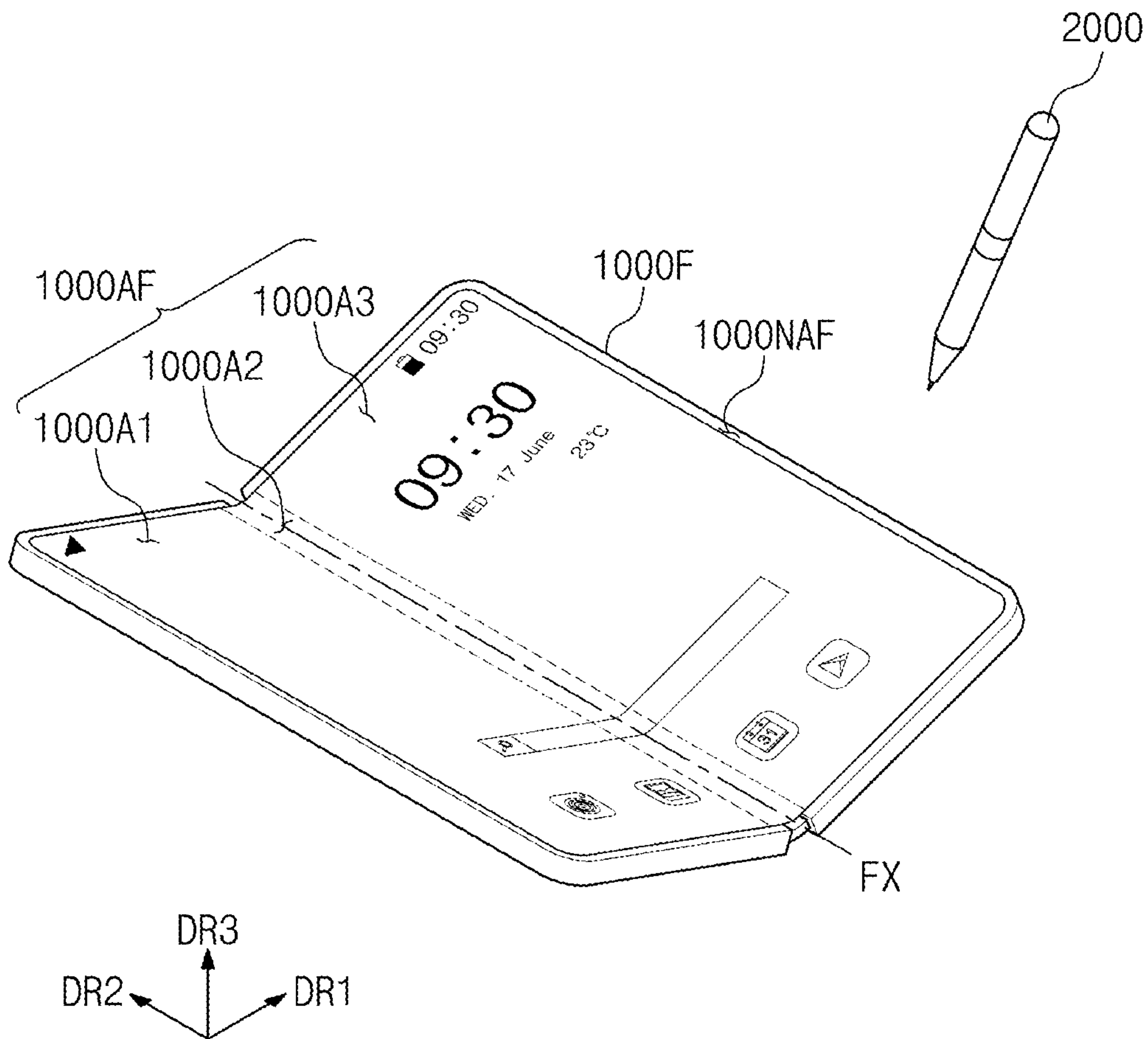


FIG. 3

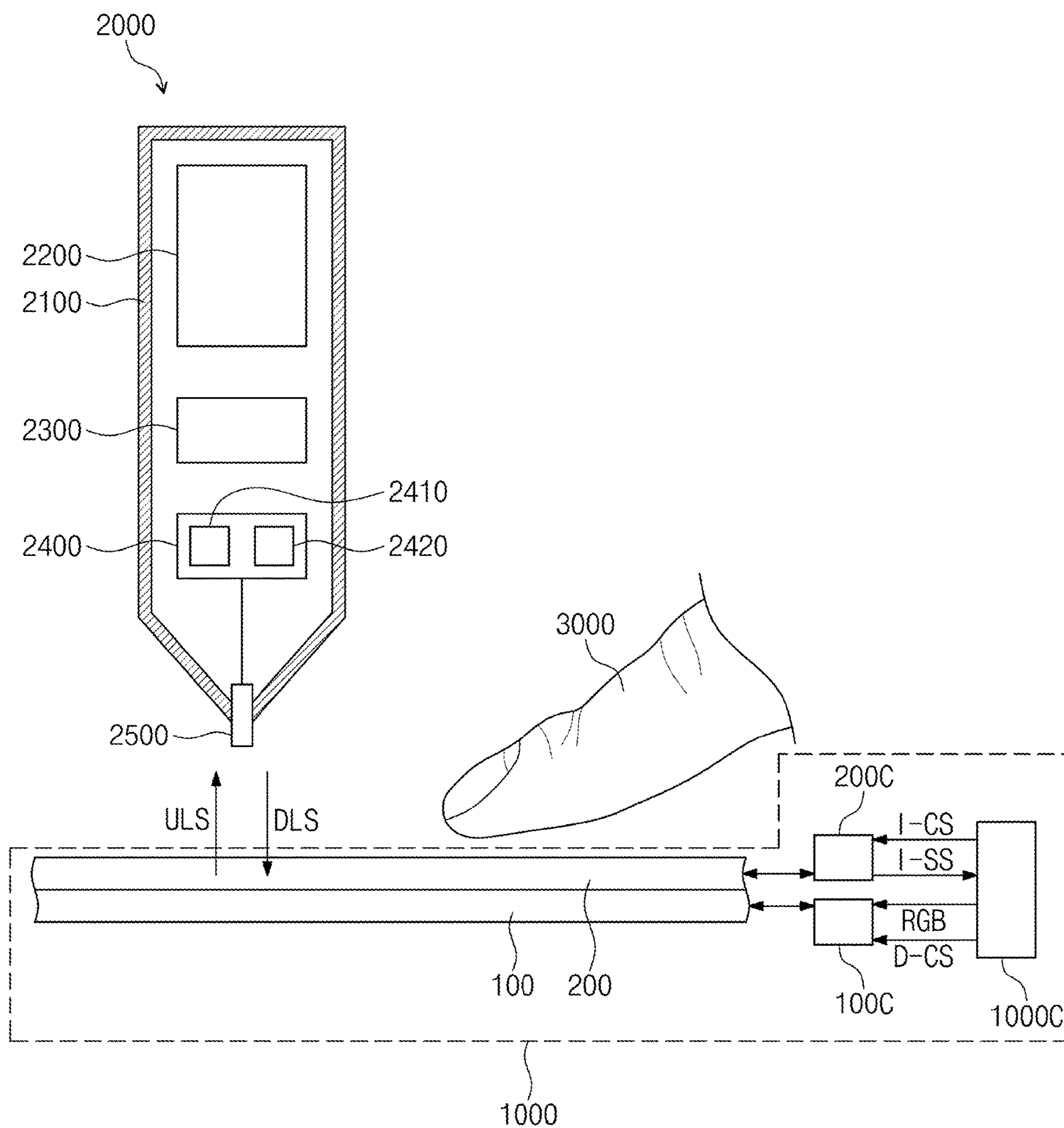


FIG. 4A

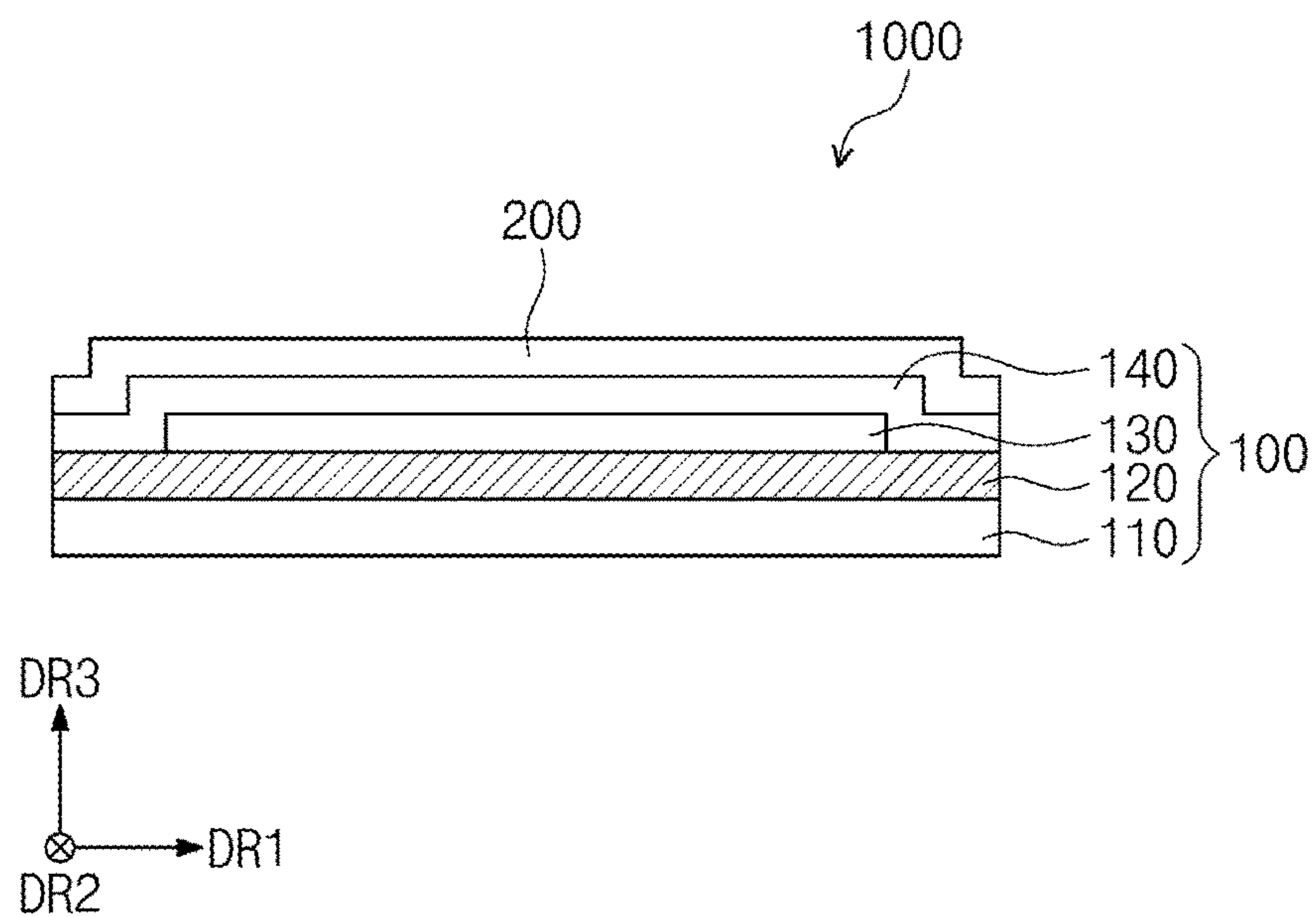


FIG. 4B

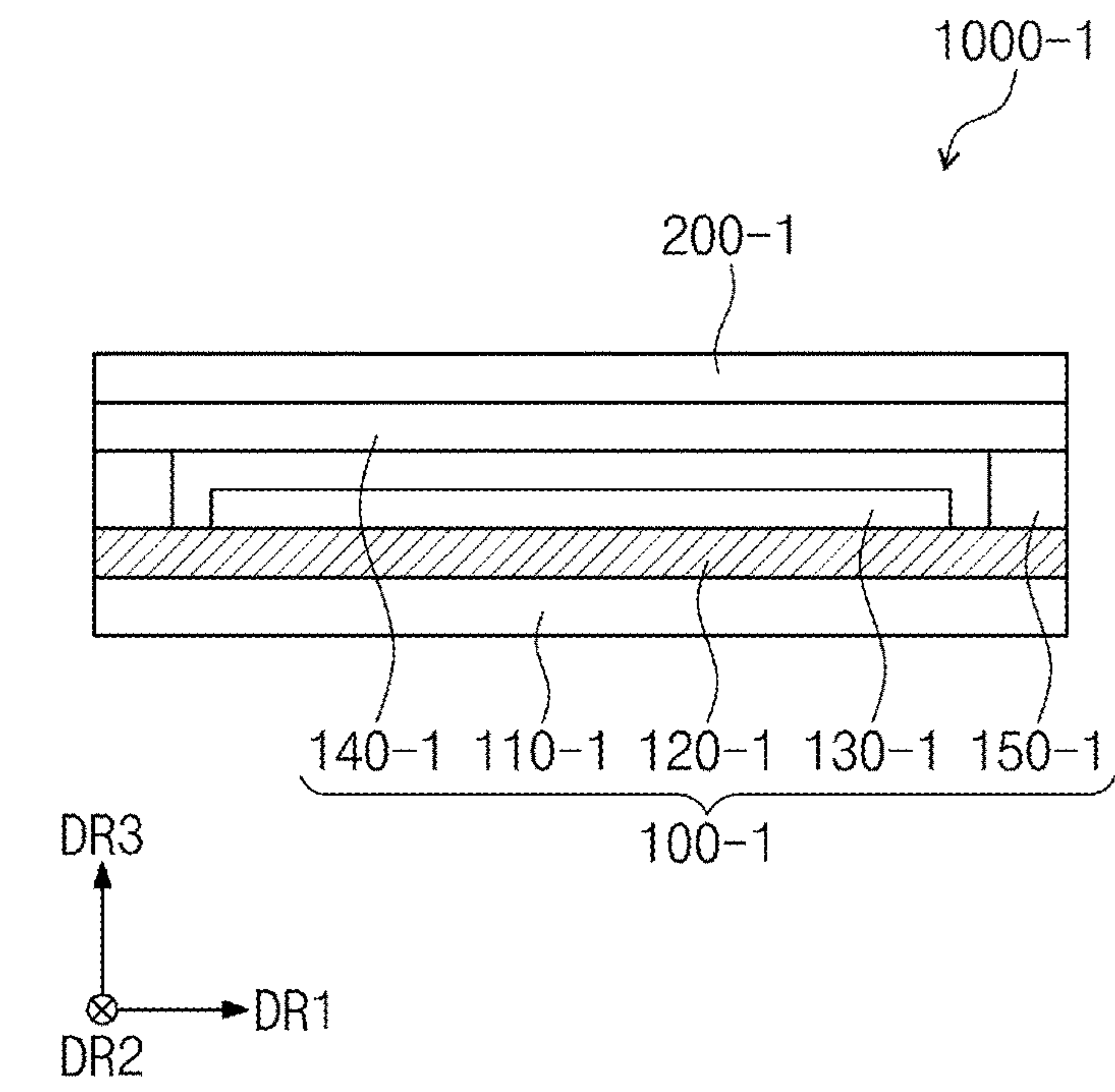


FIG. 5

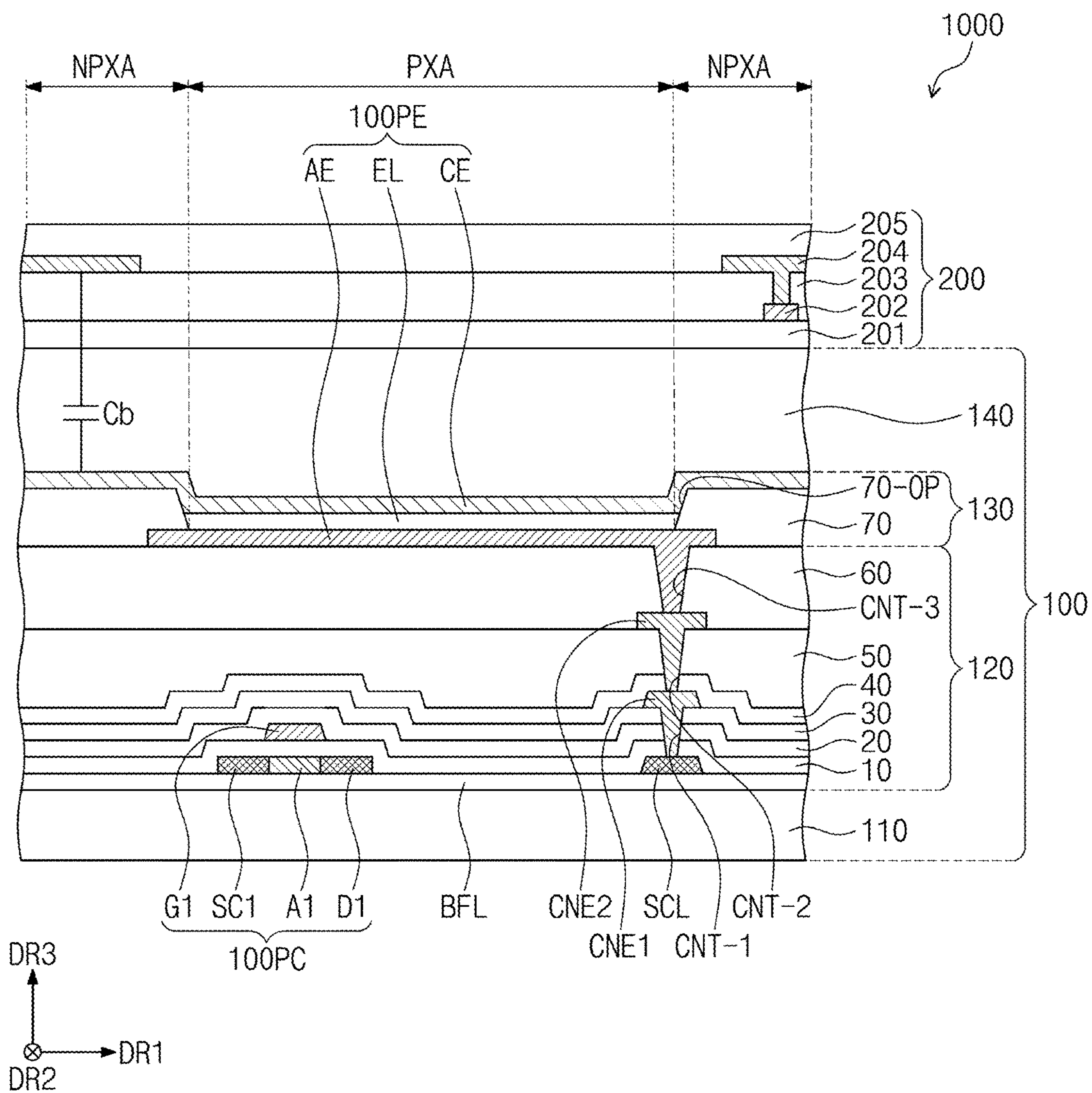


FIG. 6

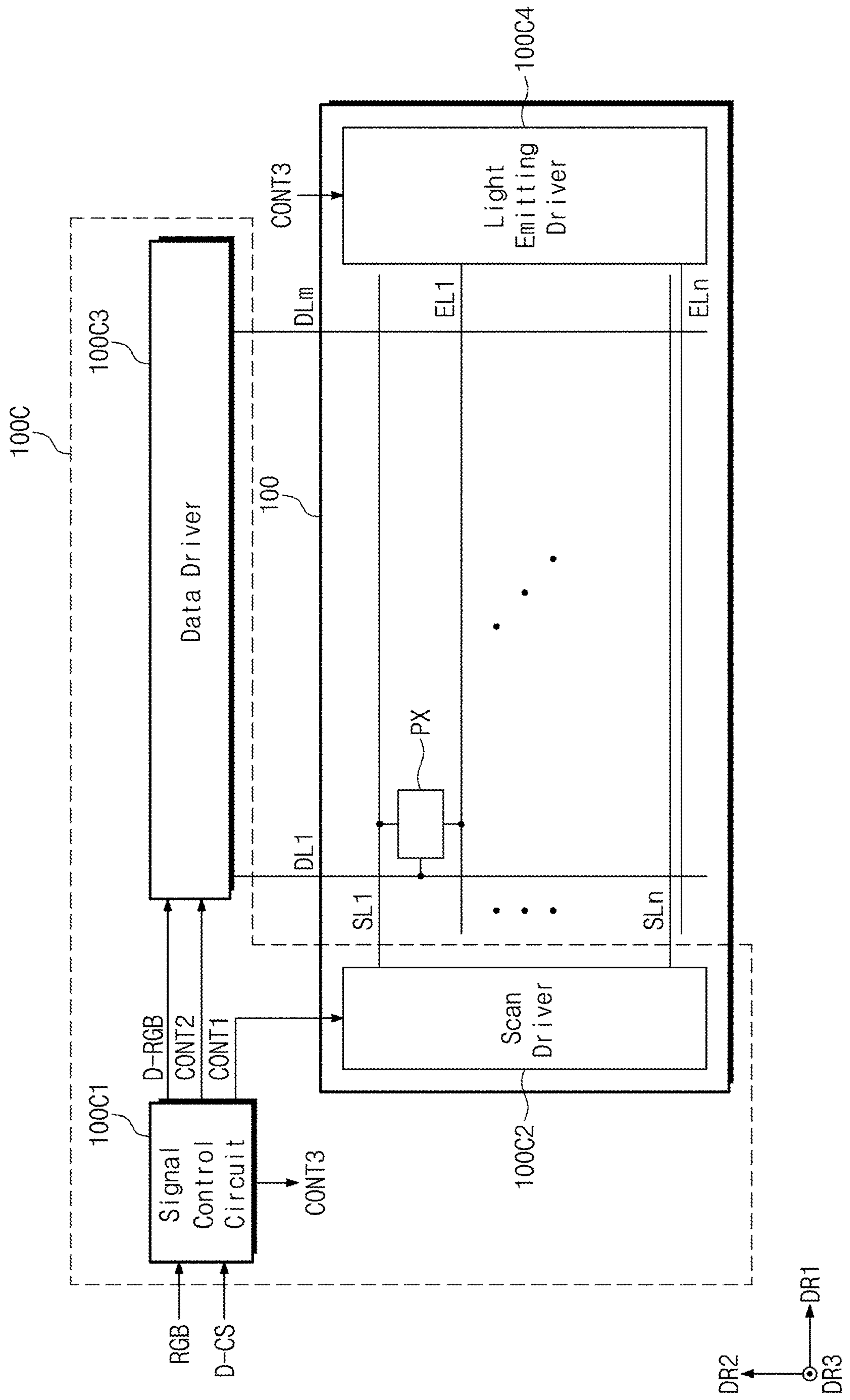


FIG. 7

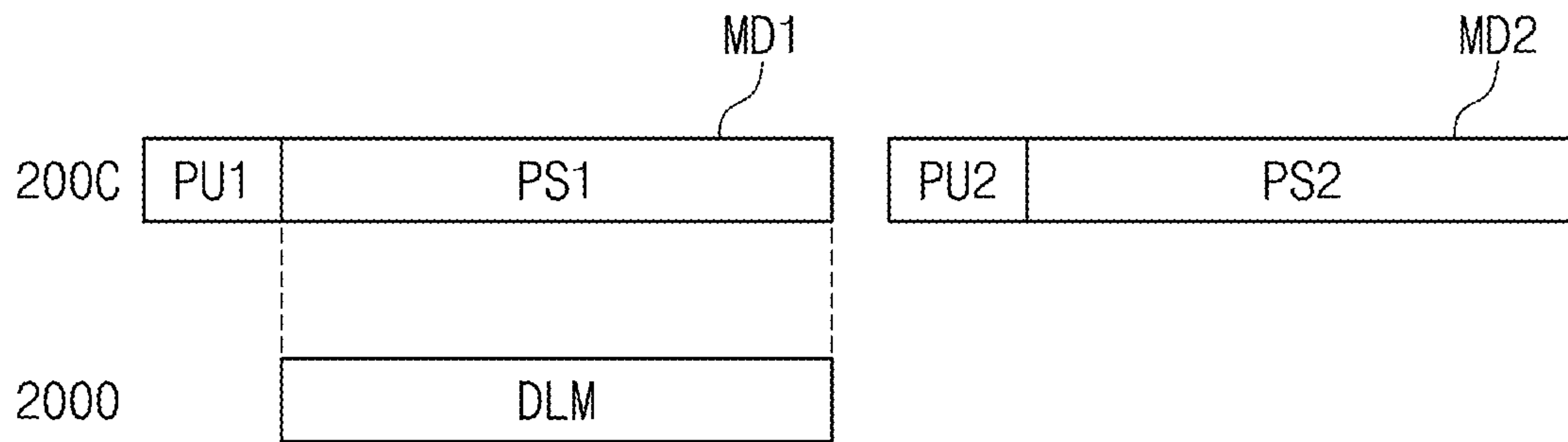


FIG. 8

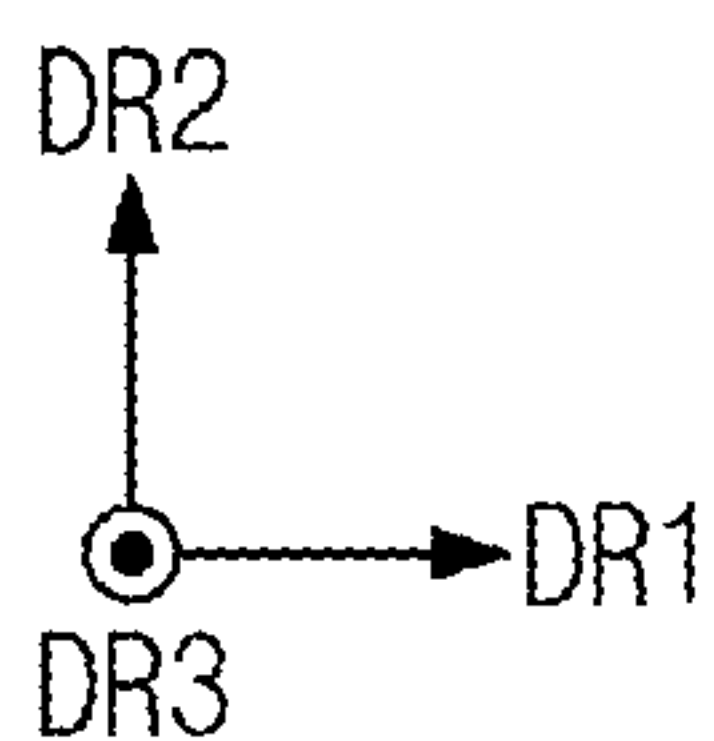
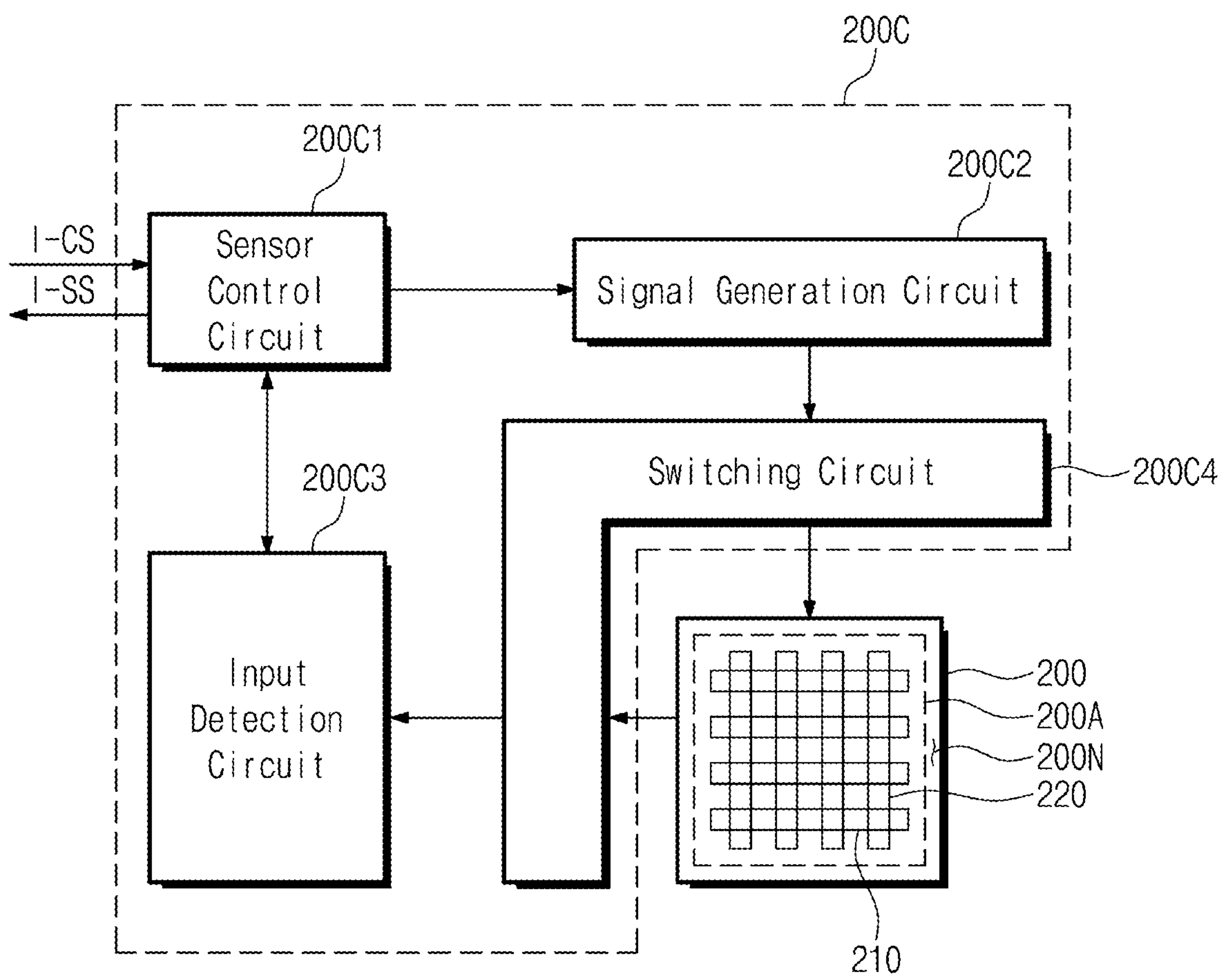


FIG. 9A

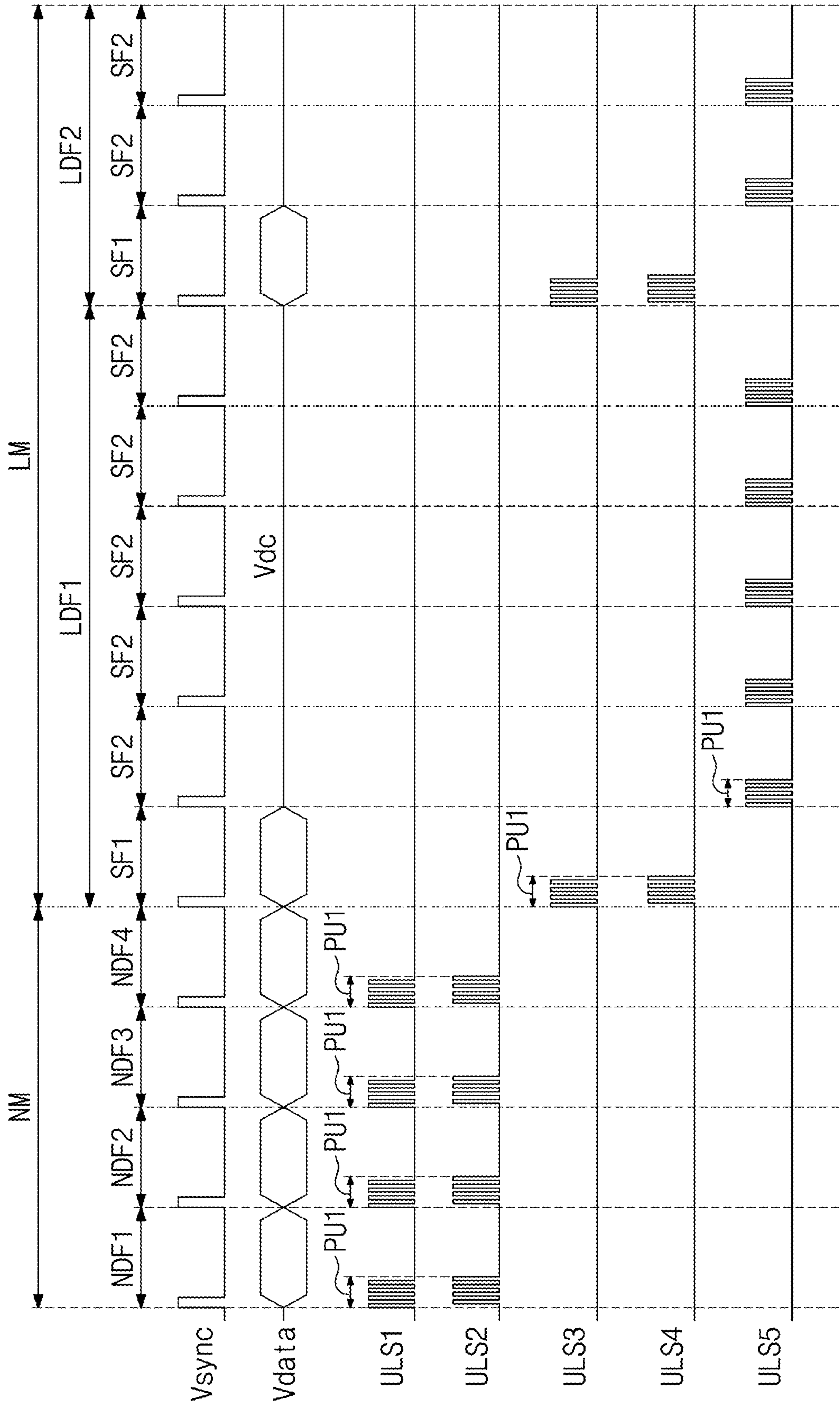


FIG. 9B

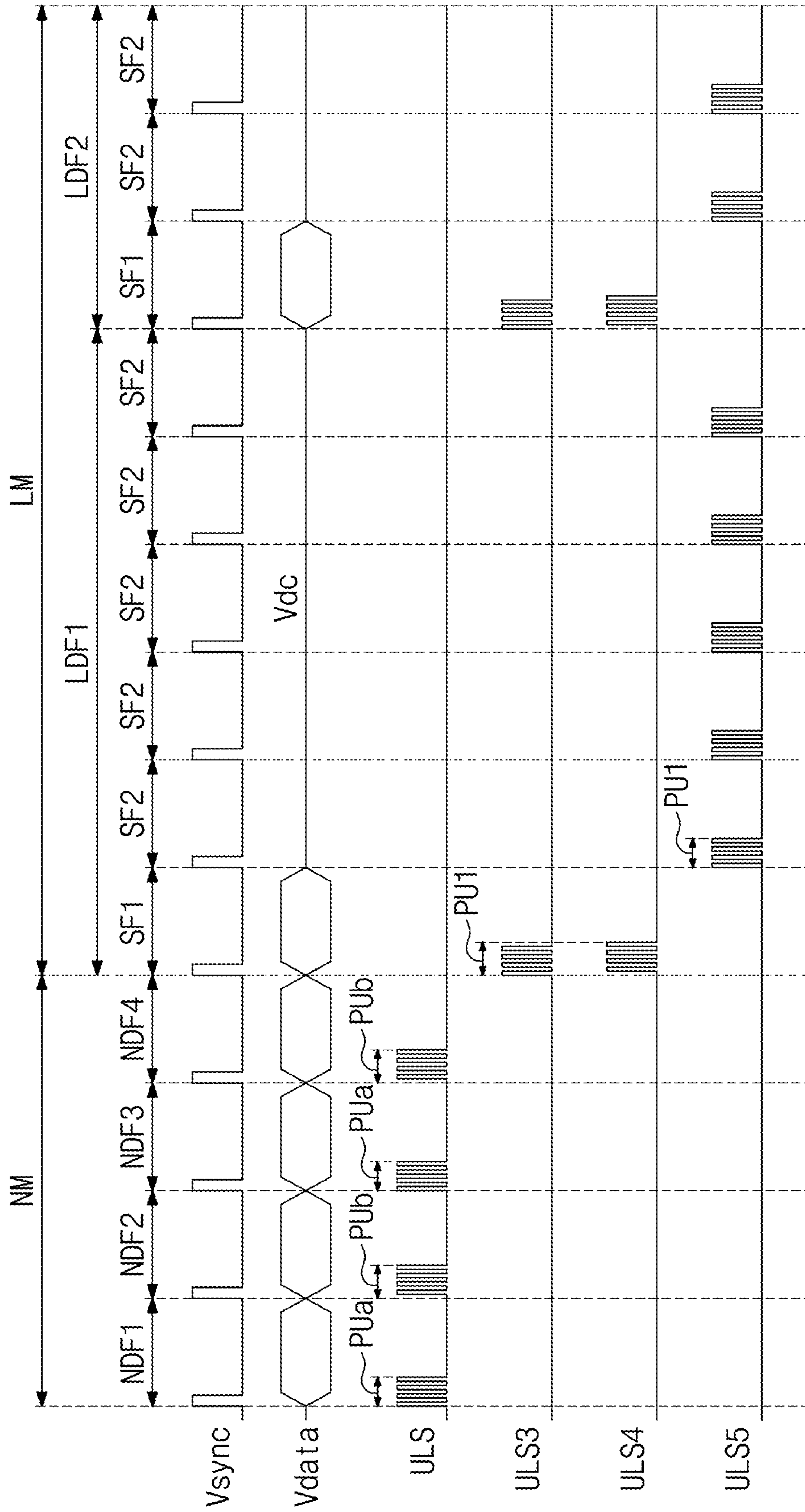


FIG. 10A

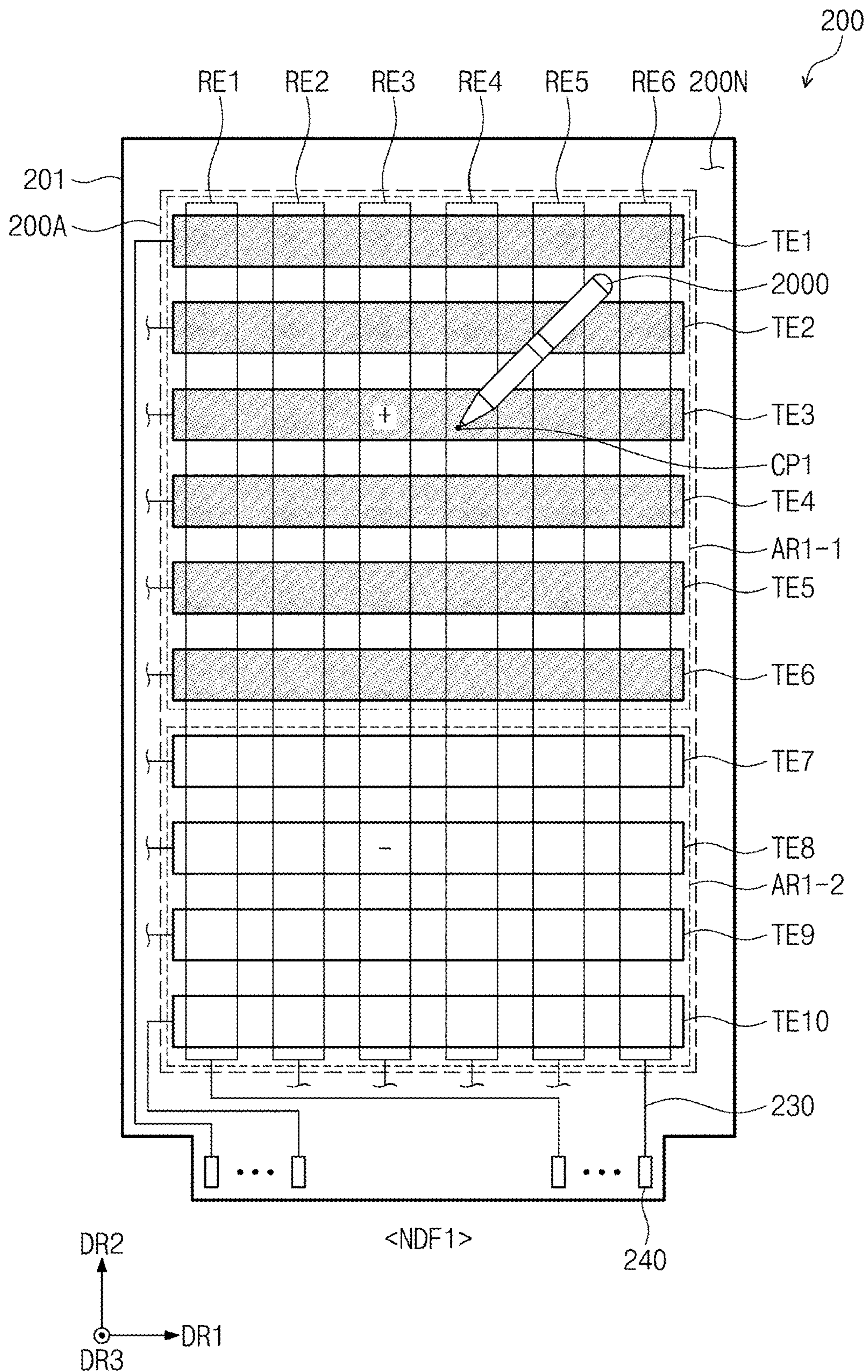


FIG. 10B

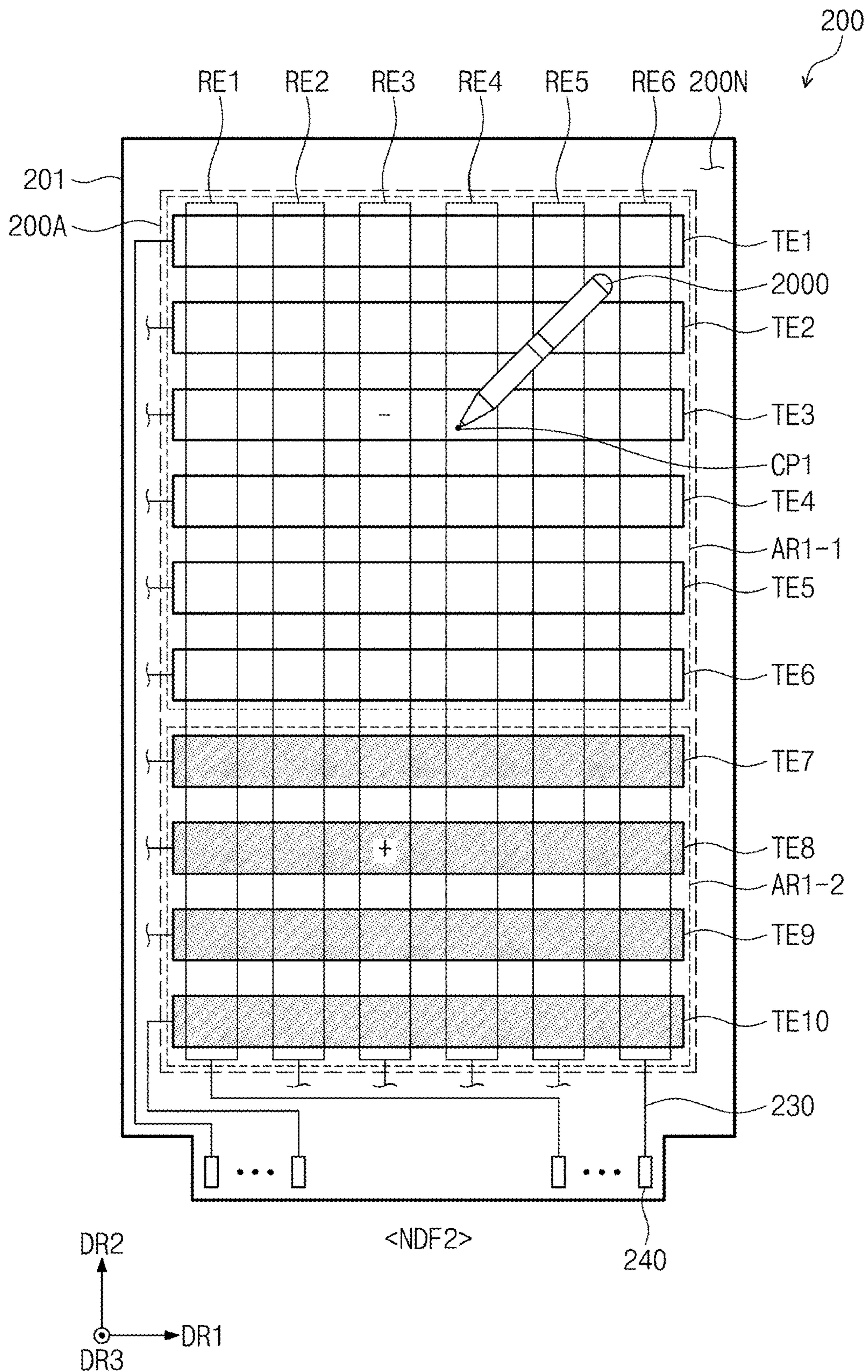


FIG. 10C

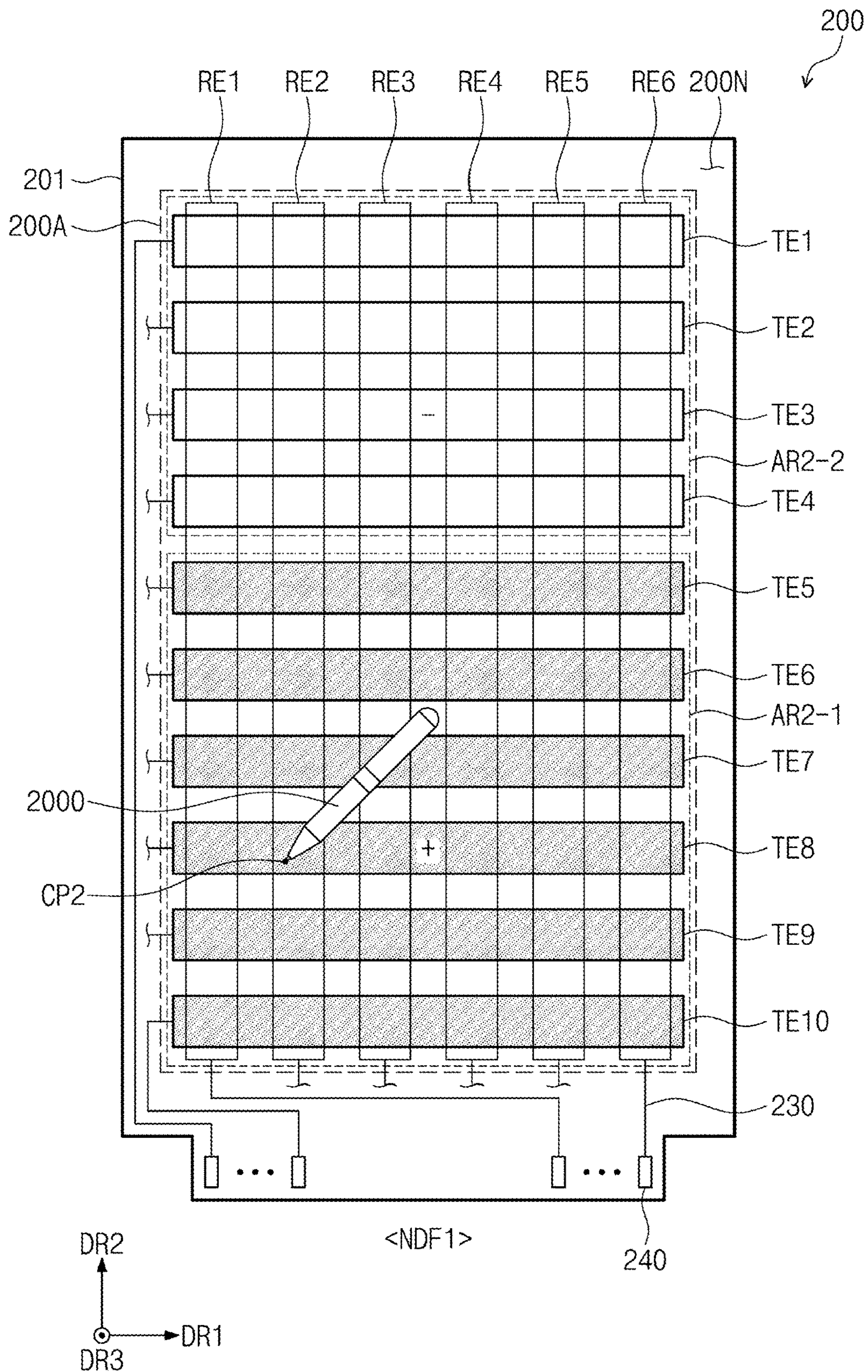


FIG. 10D

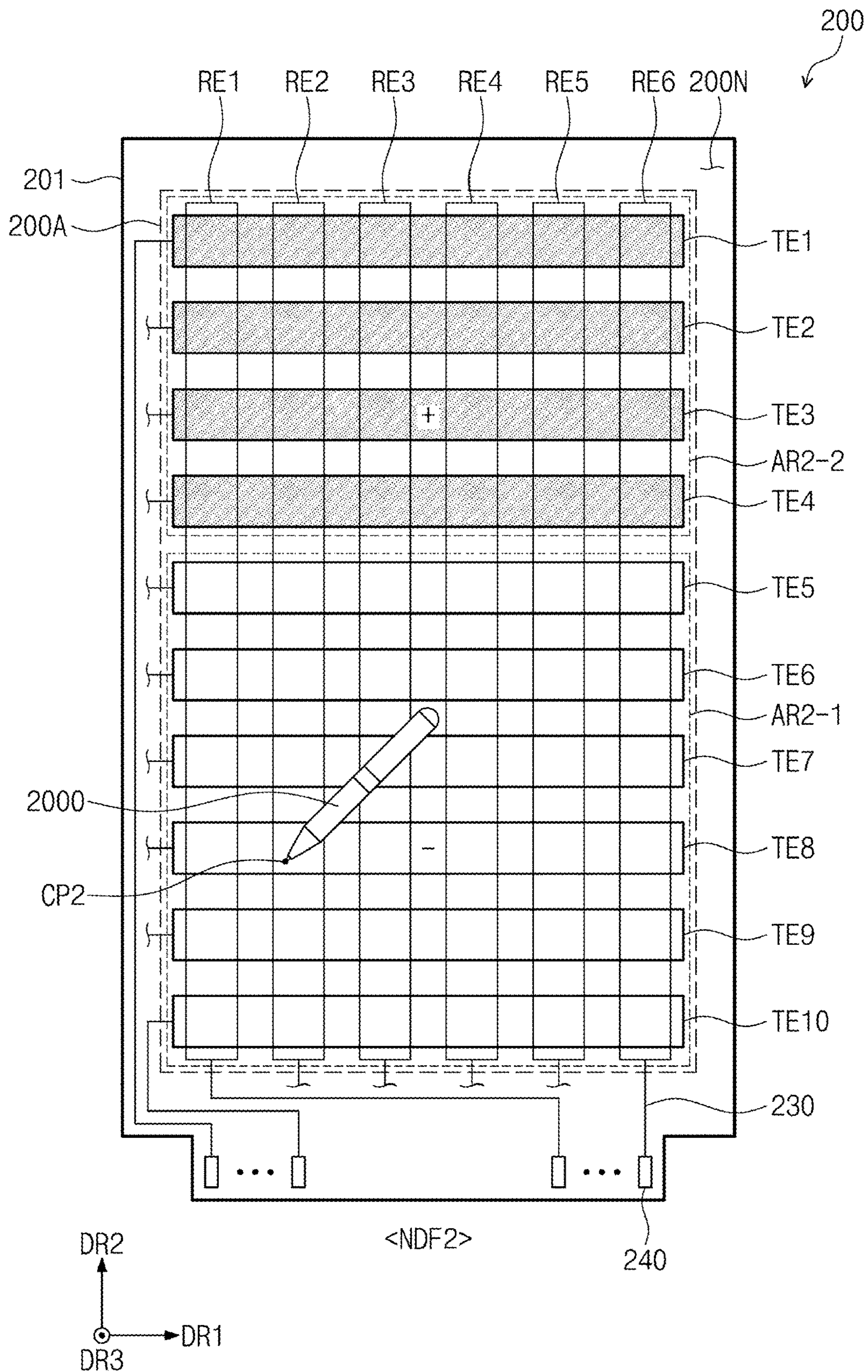


FIG. 11A

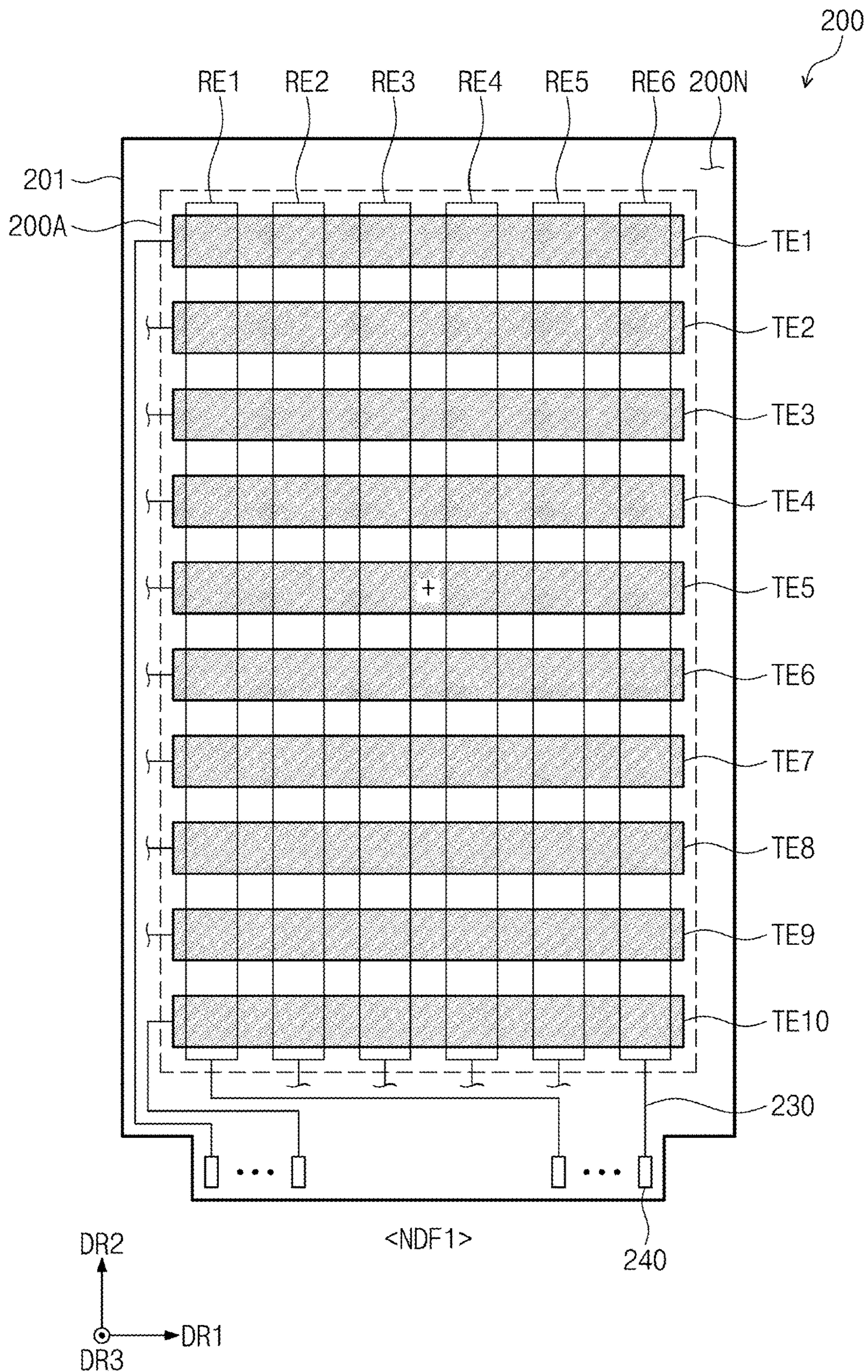


FIG. 11B

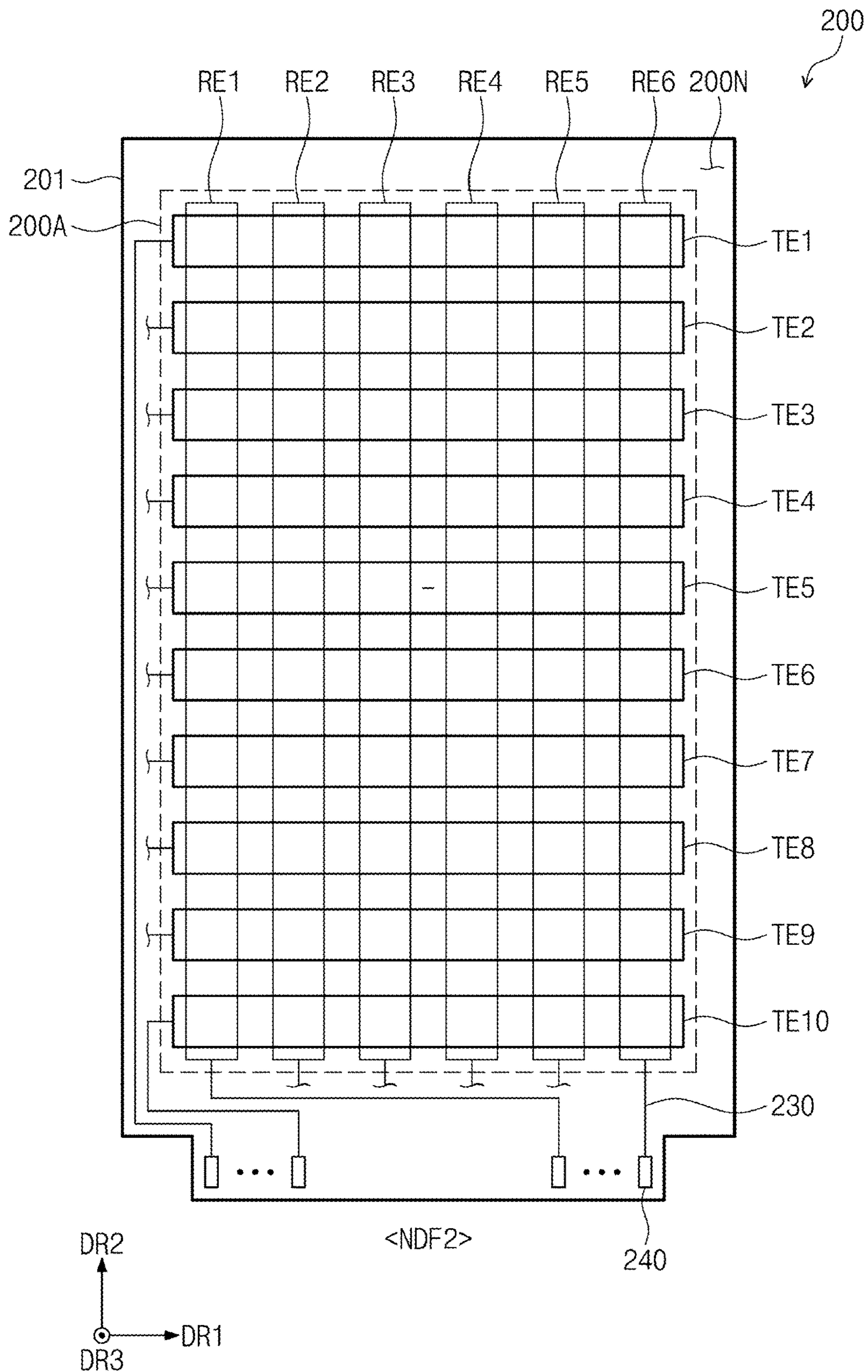


FIG. 12

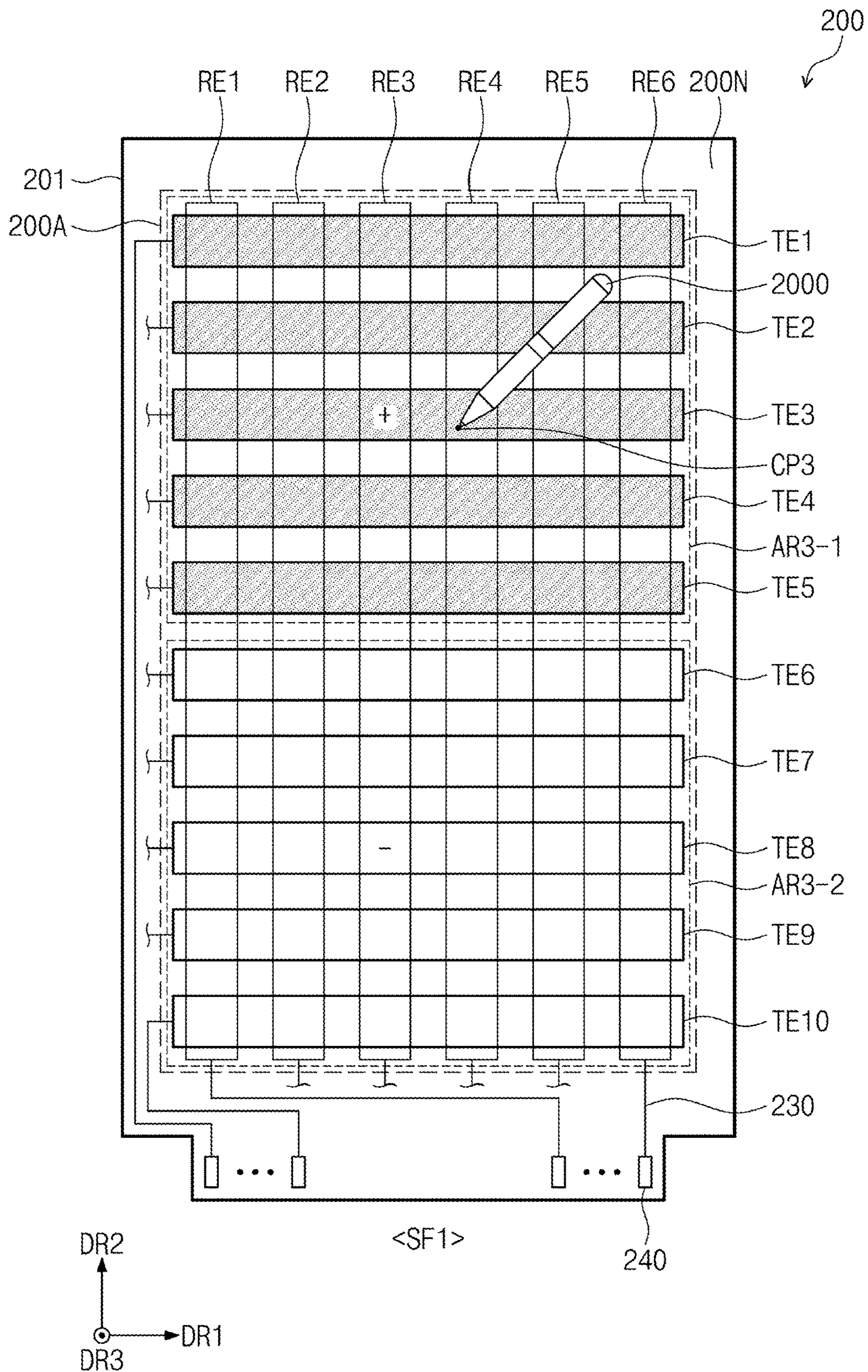


FIG. 13A

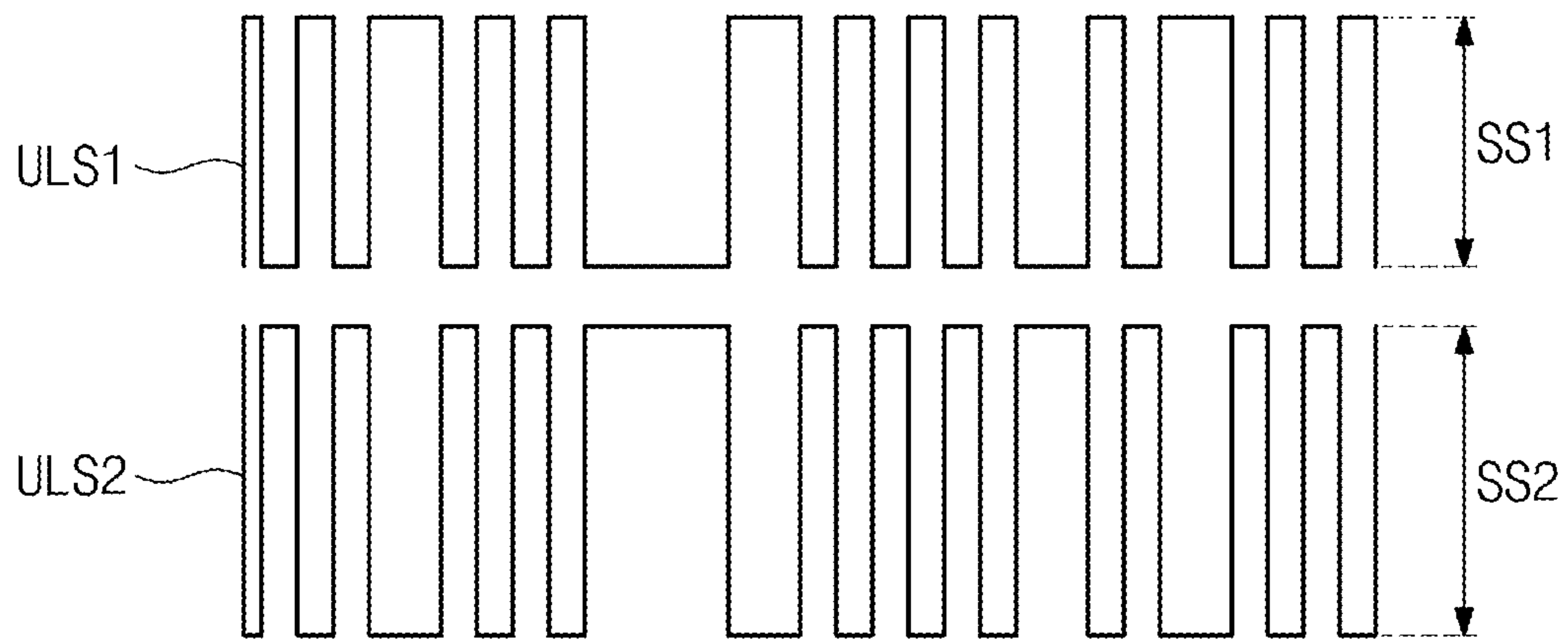


FIG. 13B

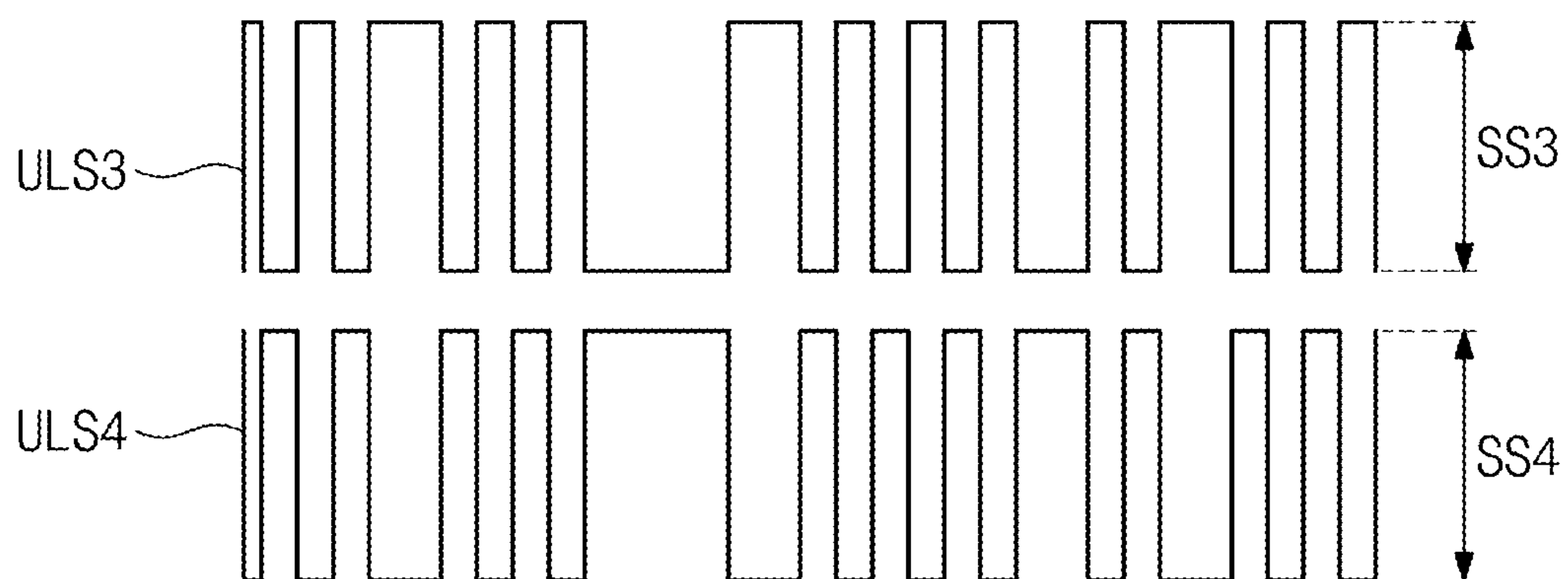


FIG. 14A

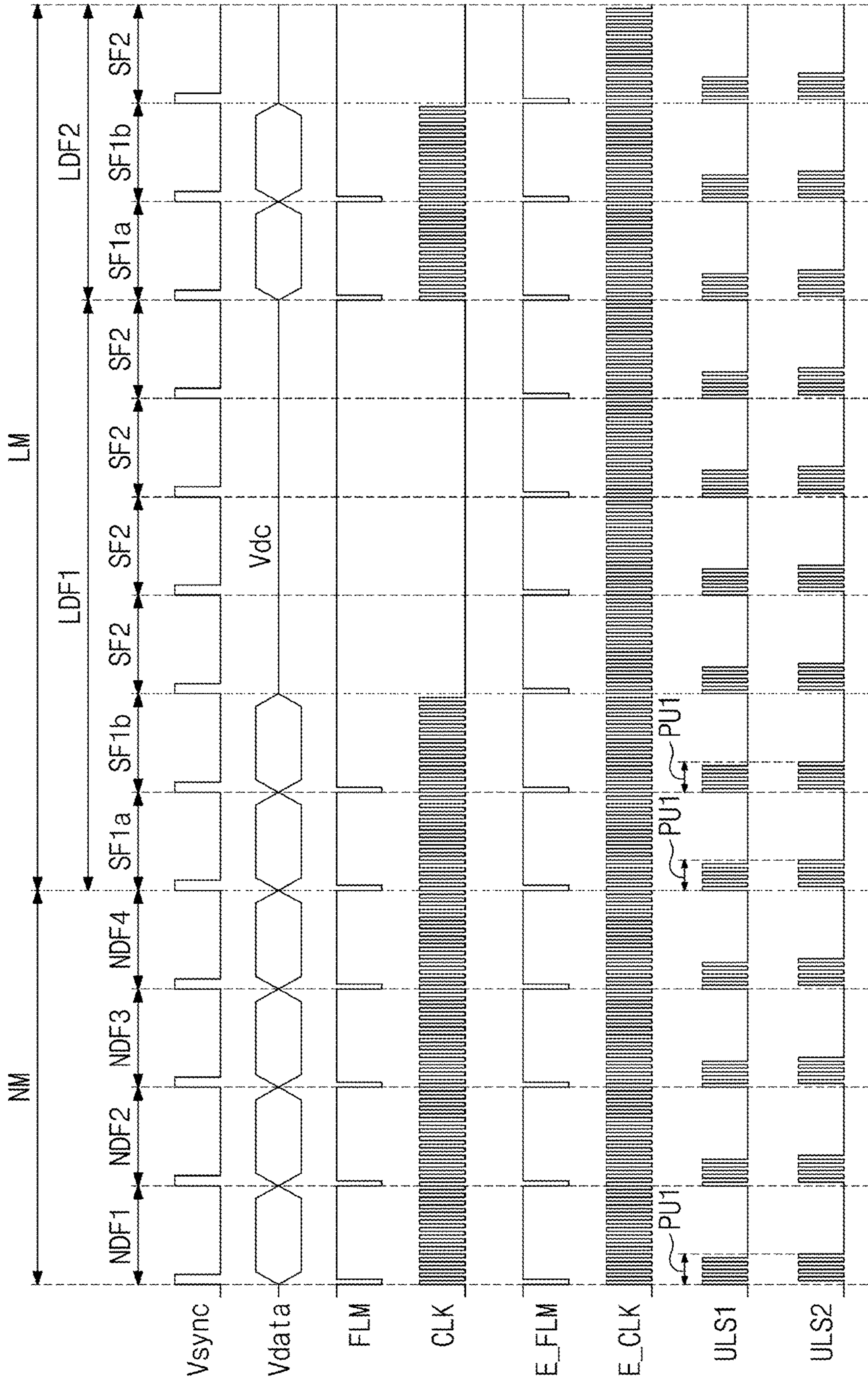


FIG. 14B

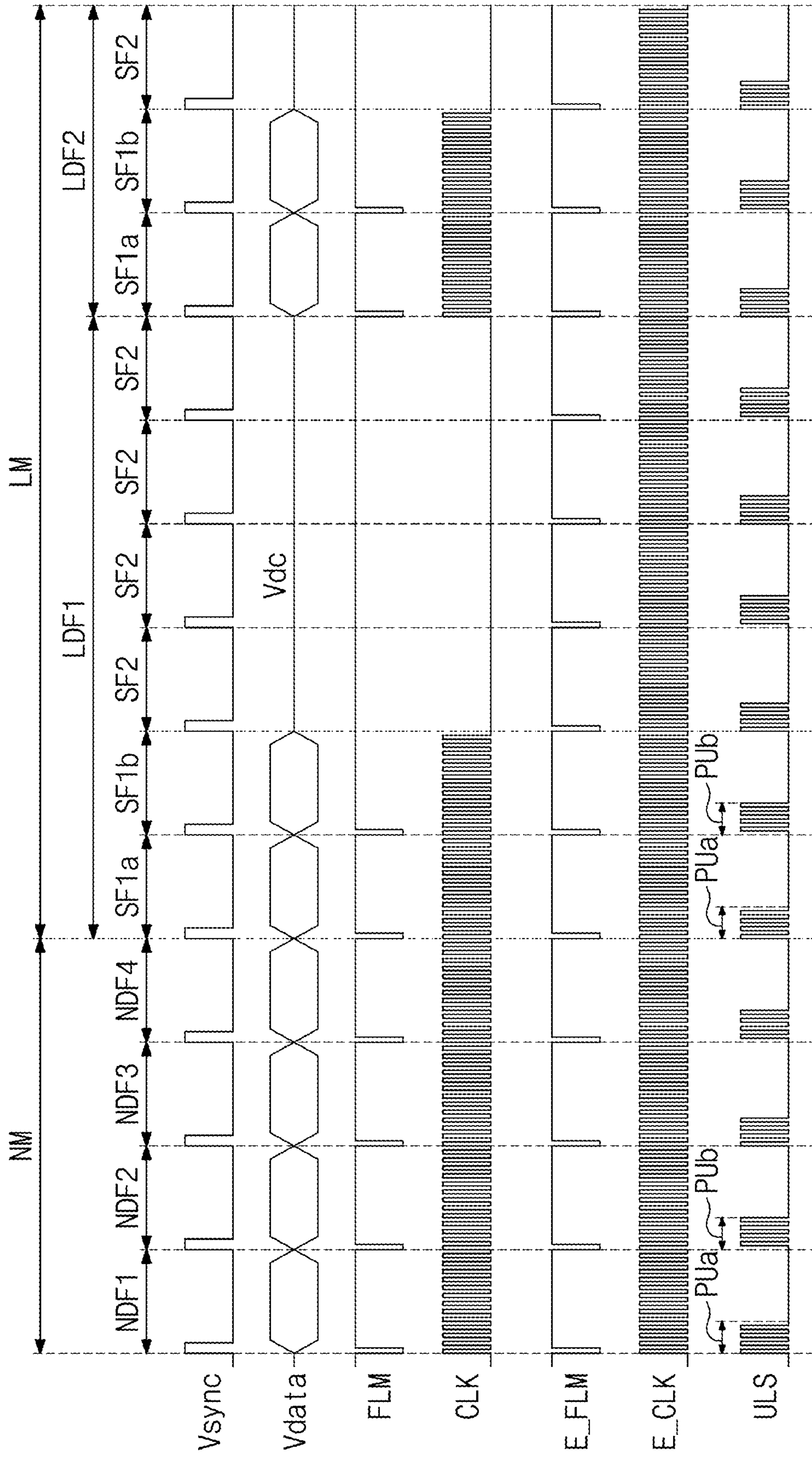


FIG. 15A

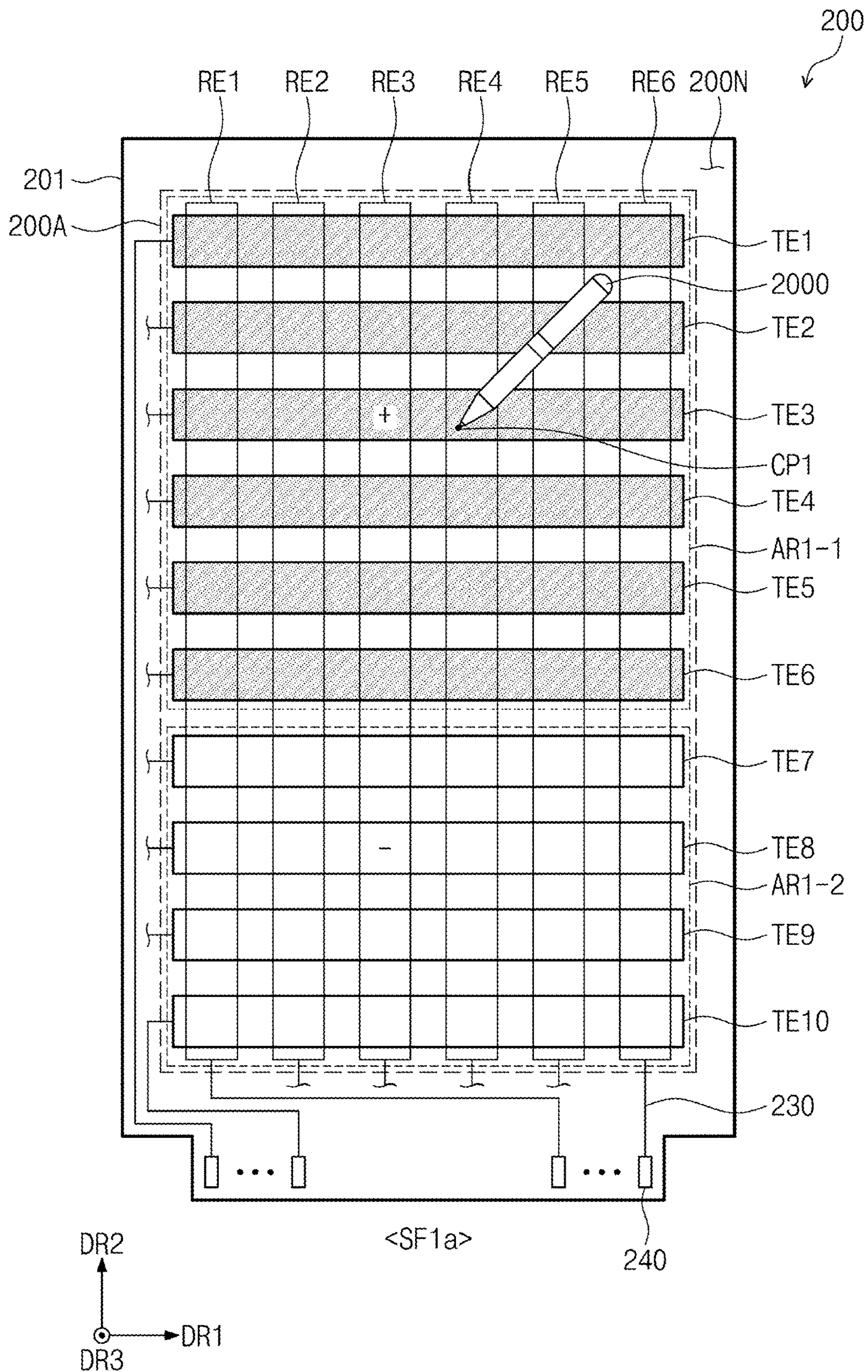


FIG. 15B

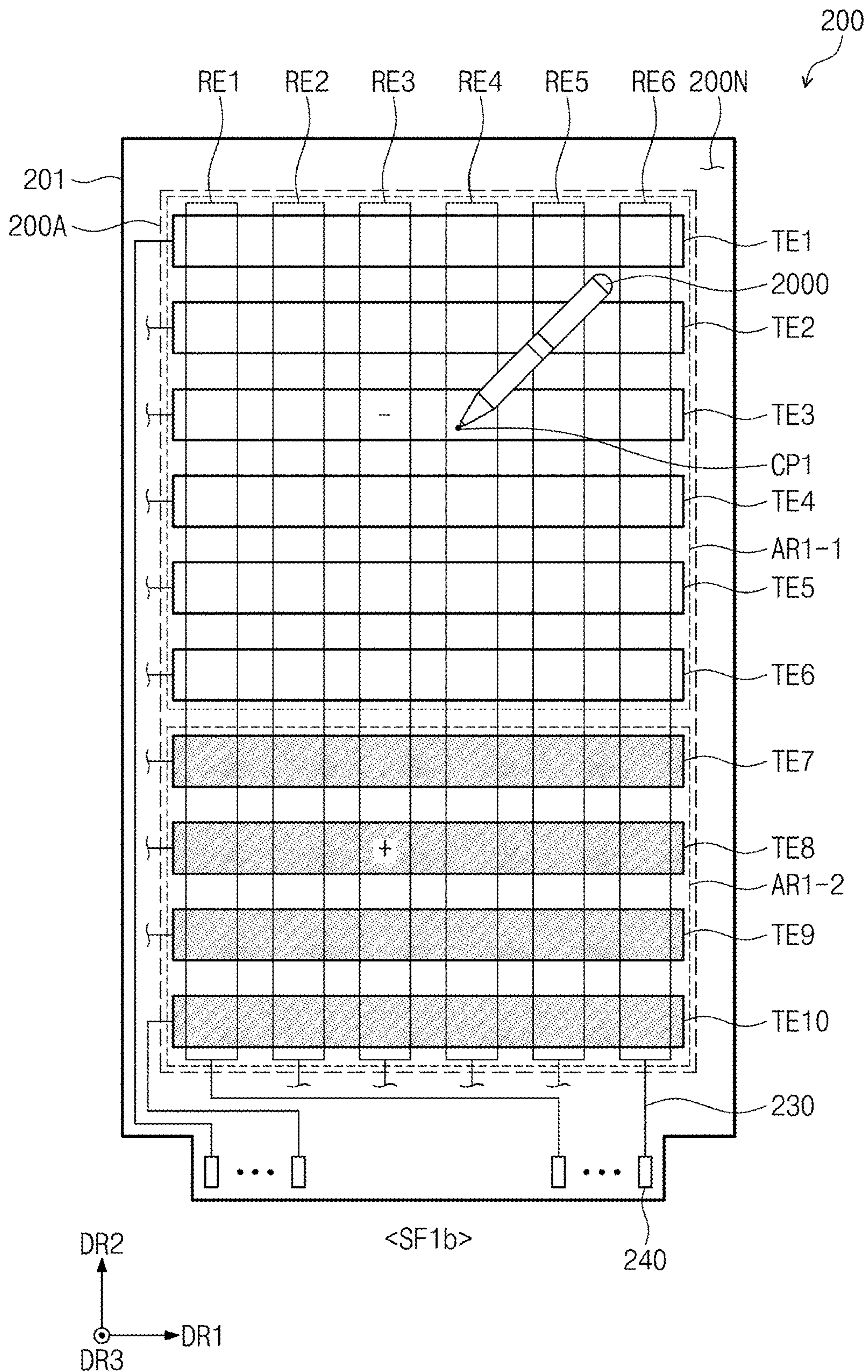


FIG. 15C

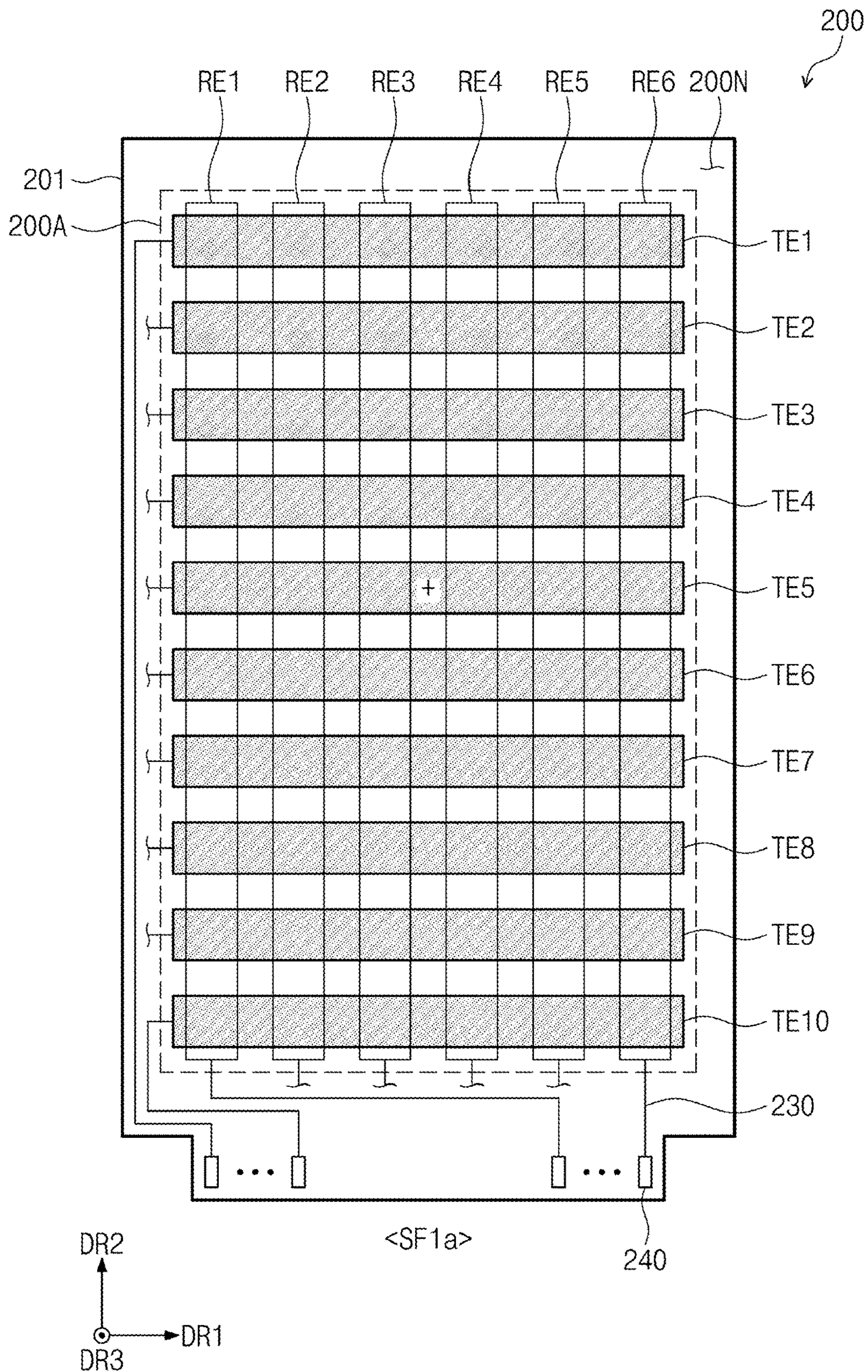


FIG. 15D

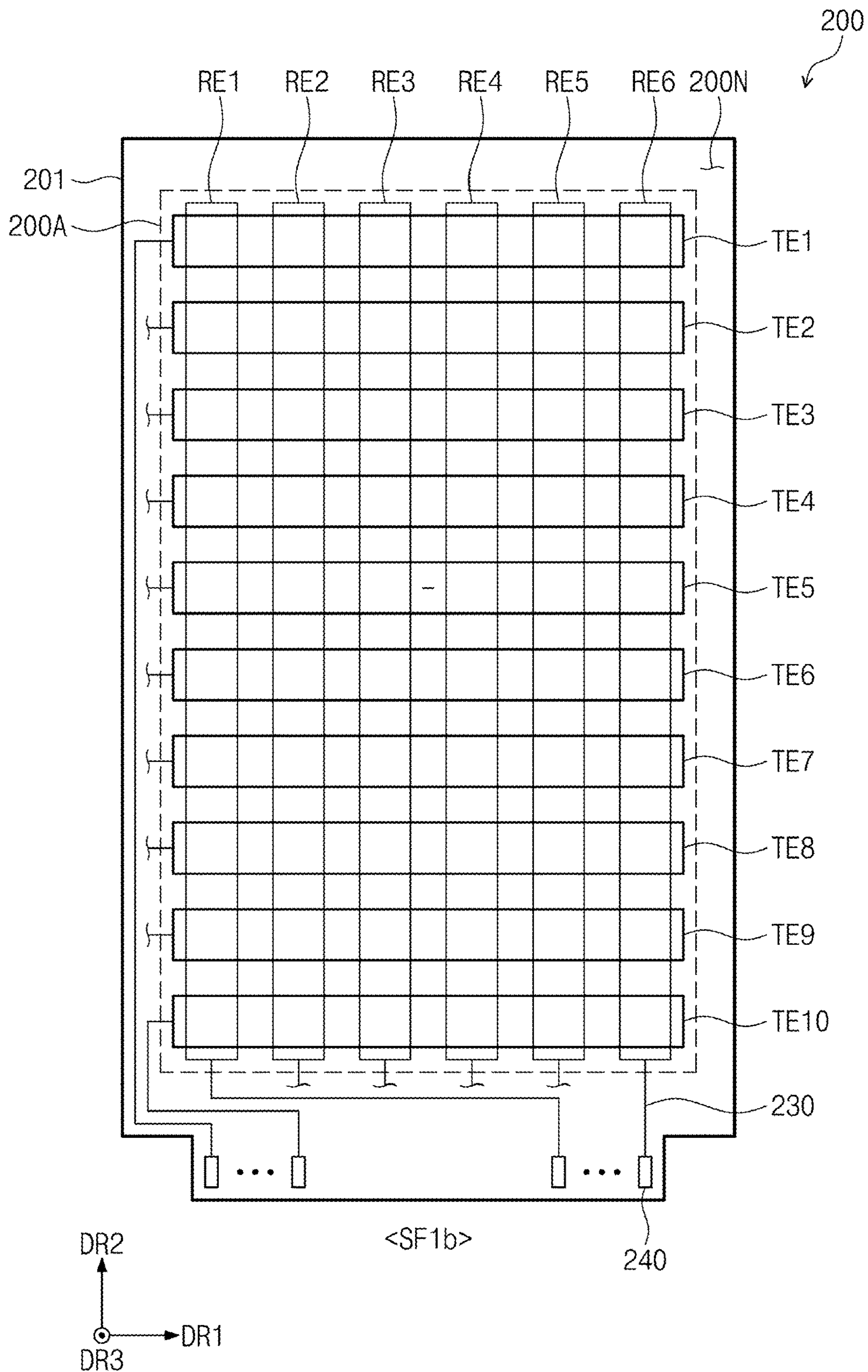


FIG. 16A

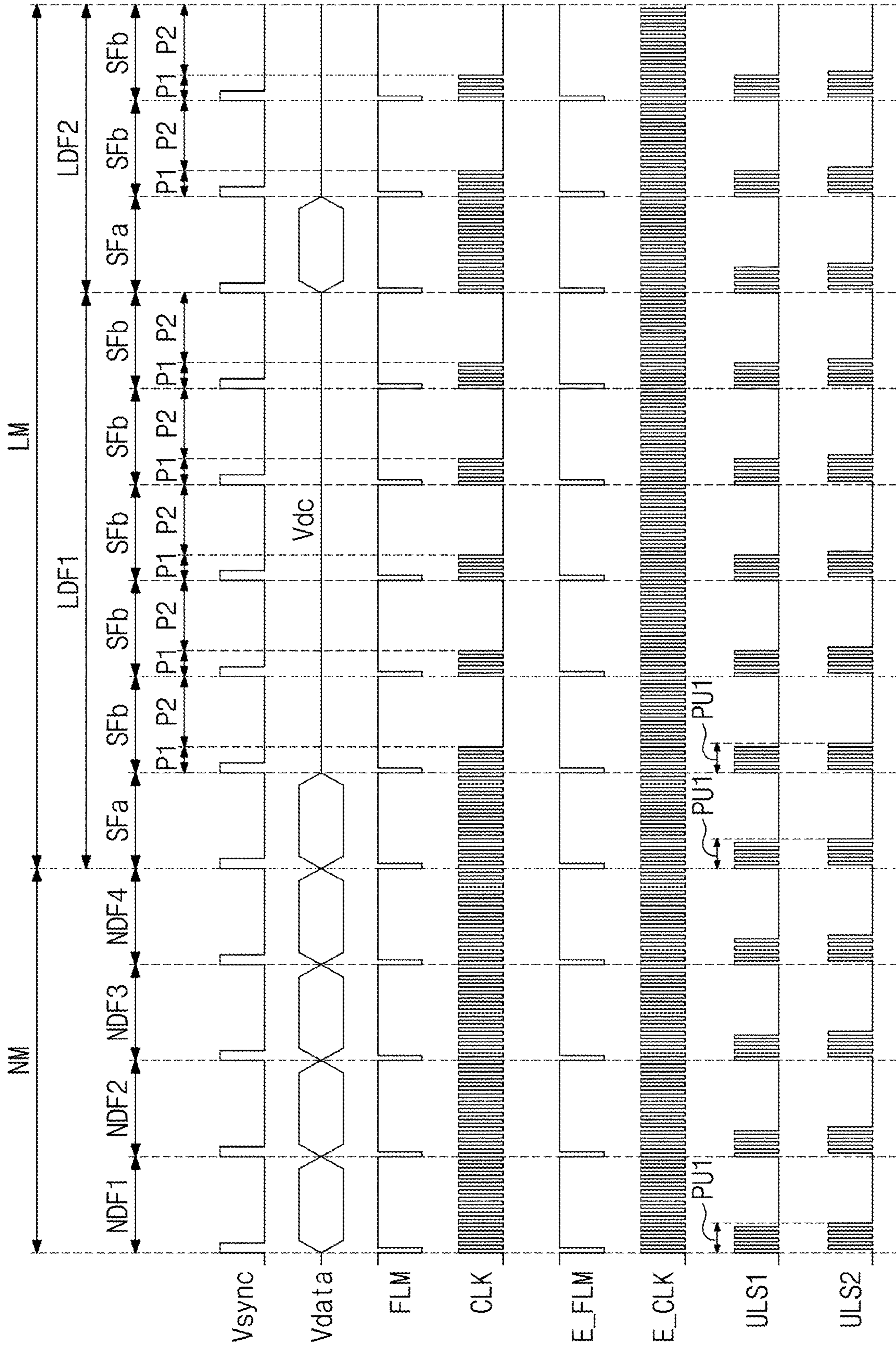


FIG. 16B

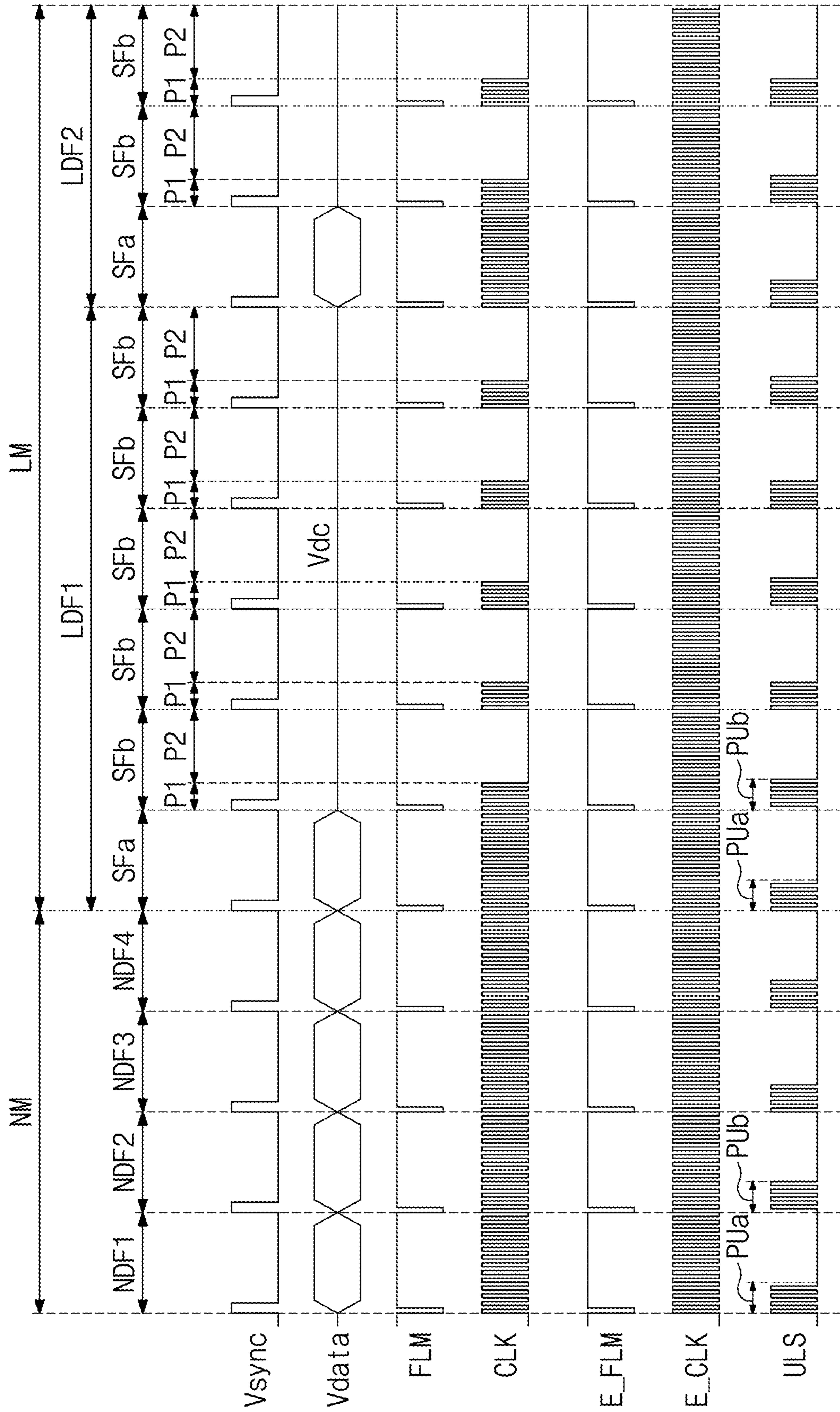


FIG. 17A

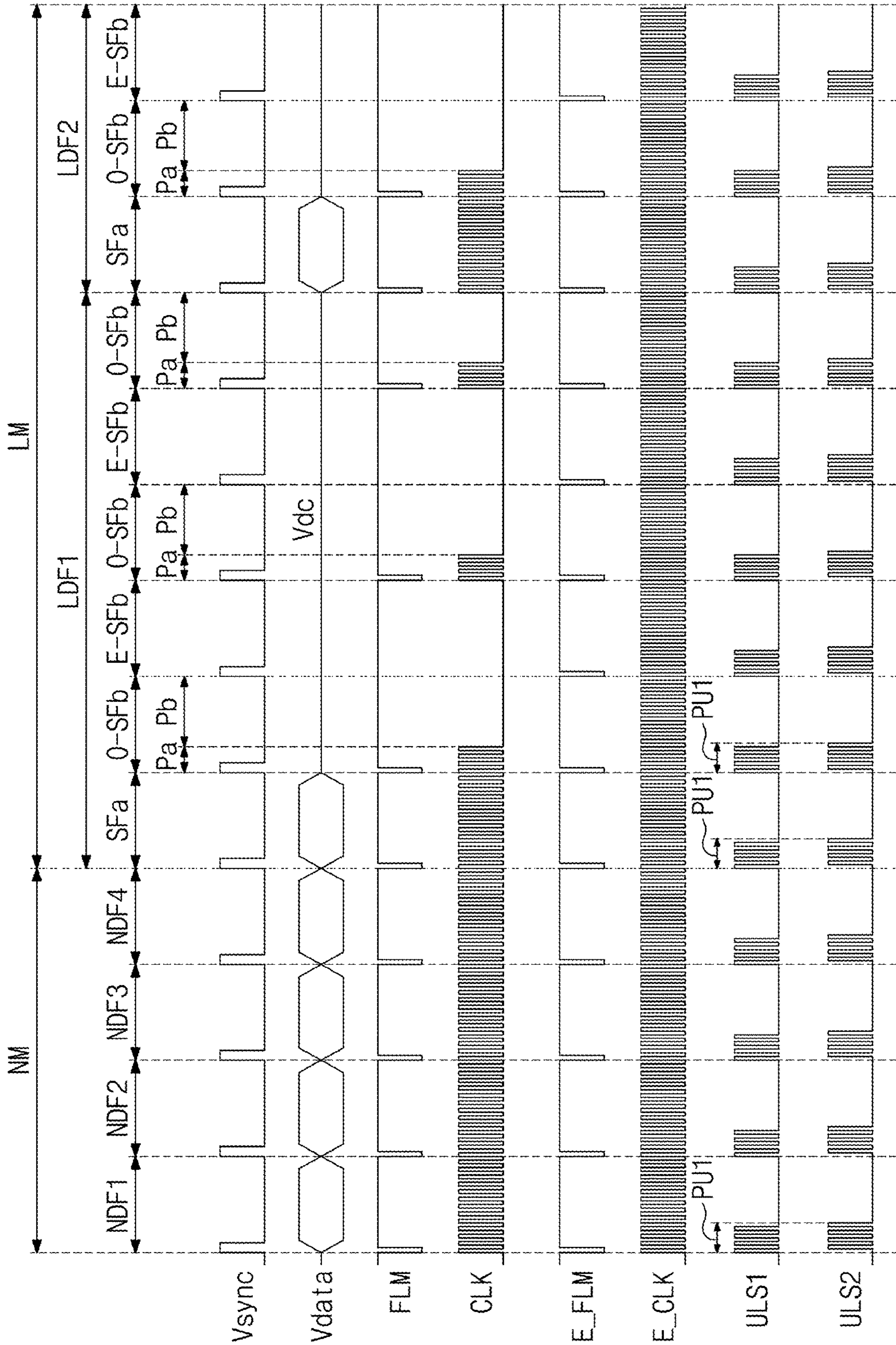
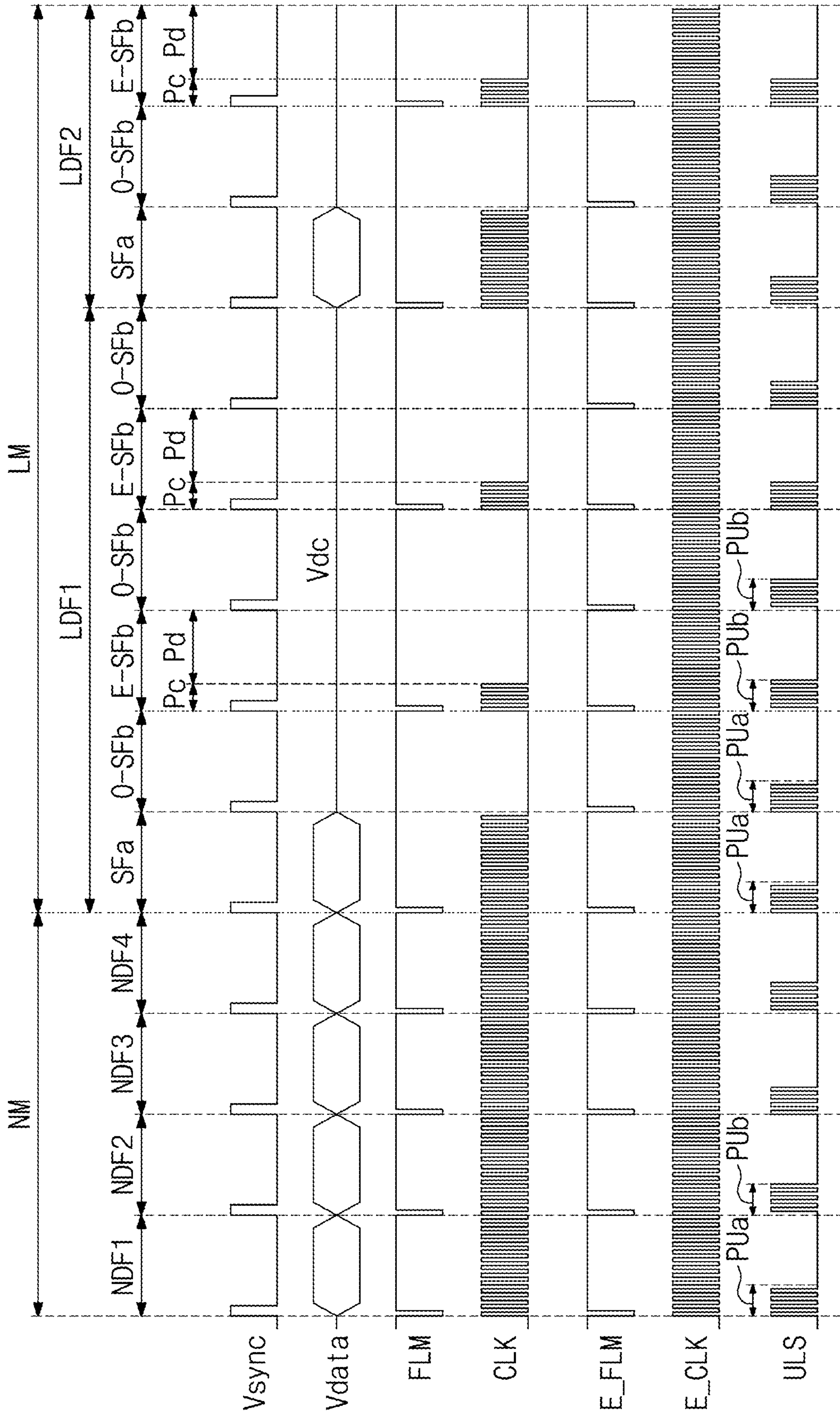


FIG. 17B



1**ELECTRONIC DEVICE****CROSS-REFERENCE TO RELATED APPLICATIONS**

The present application claims priority to and the benefit of Korean Patent Application No. 10-2021-0135420 filed on Oct. 13, 2021, in the Korean Intellectual Property Office, the entire disclosure of which is incorporated herein by reference.

BACKGROUND**1. Field**

Aspects of some embodiments of the present disclosure described herein relate to an electronic device.

2. Description of the Related Art

An electronic device may detect external inputs applied from the outside of the electronic device. The external input may be a user input. The user input may include various types of external inputs from various sources such as, for example, a part of the user's body, light, heat, a pen, a stylus, proximity, pressure, or the like. The electronic device may recognize coordinates of the pen using an electromagnetic resonance (EMR) scheme or may recognize coordinates of the pen using an active electrostatic (AES) scheme.

The above information disclosed in this Background section is only for enhancement of understanding of the background and therefore the information discussed in this Background section does not necessarily constitute prior art.

SUMMARY

Aspects of some embodiments of the present disclosure described herein relate to an electronic device, and for example, to an electronic device with relatively improved display quality.

Aspects of some embodiments of the present disclosure include an electronic device for enhancing a phenomenon in which display quality is degraded due to noise associated with an input sensor.

According to some embodiments, an electronic device may include a display panel that displays an image, an input sensor on the display panel and to operate in a first mode for detecting a first input by an input device or a second mode for detecting a second input different from the first input, a panel driver that drives the display panel at a first operating frequency in a first driving mode and drives the display panel at a second operating frequency lower than the first operating frequency in a second driving mode, and a sensor controller that controls driving of the input sensor.

According to some embodiments, the display panel may display the image in units of first driving frames in the first driving mode and may display the image in units of second driving frames in the second driving mode.

According to some embodiments, the sensor controller may transmit a first mode uplink signal for synchronization with the input device to the input sensor in a first scheme in the first driving mode and may transmit a second mode uplink signal for synchronization with the input device to the input sensor in a second scheme different from the first scheme in the second driving mode.

According to some embodiments, an electronic device may include a display panel that displays an image, an input

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sensor on the display panel to operate in a first mode for detecting a first input by an input device or a second mode for detecting a second input different from the first input, a panel driver that drives the display panel at a first operating frequency in a first driving mode and drives the display panel at a second operating frequency lower than the first operating frequency in a second driving mode, and a sensor controller that controls driving of the input sensor.

According to some embodiments, the display panel may display the image in units of first driving frames in the first driving mode and may display the image in units of second driving frames in the second driving mode. The second driving frames may include k write frames and j holding frames. Herein the k is an even number of 2 or more.

According to some embodiments, an electronic device may include a display panel that displays an image at a first operating frequency in a first driving mode and displays the image at a second operating frequency lower than the first operating frequency in a second driving mode, an input sensor on the display panel to operate in a first mode for detecting a first input by an input device or a second mode for detecting a second input different from the first input, a data driver that outputs data signals to the display panel, a scan driver that outputs scan signals to the display panel, and a sensor controller that controls driving of the input sensor and transmits an uplink signal for synchronization with the input device during an uplink interval.

According to some embodiments, the display panel may display the image in units of first driving frames in the first driving mode and may display the image in units of second driving frames in the second driving mode. The second driving frames may include a first sub-frame and a plurality of second sub-frames. At least one of the plurality of second sub-frames may include an active interval where the scan driver is activated and an inactive interval where the scan driver is deactivated.

BRIEF DESCRIPTION OF THE DRAWINGS

The above and other characteristics and features of the present disclosure will become more apparent by describing in more detail aspects of some embodiments thereof with reference to the accompanying drawings.

FIGS. 1 and 2 are perspective views illustrating an electronic device and an input device according to some embodiments of the present disclosure.

FIG. 3 is a block diagram schematically illustrating an electronic device and an input device according to some embodiments of the present disclosure.

FIGS. 4A and 4B are cross-sectional views of an electronic device according to some embodiments of the present disclosure.

FIG. 5 is a cross-sectional view of an electronic device according to some embodiments of the present disclosure.

FIG. 6 is a block diagram of a display panel and a panel driver according to some embodiments of the present disclosure.

FIG. 7 is a conceptual diagram illustrating operations of a first mode and a second mode according to some embodiments of the present disclosure.

FIG. 8 is a block diagram of an input sensor and a sensor controller according to some embodiments of the present disclosure.

FIGS. 9A and 9B are waveform diagrams illustrating uplink signals according to some embodiments of the present disclosure.

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FIGS. 10A, 10B, 10C, and 10D are plan views illustrating an operation of an input sensor in a first driving mode.

FIGS. 11A and 11B are plan views illustrating an operation of an input sensor in a first driving mode.

FIG. 12 is a plan view illustrating an operation of an input sensor in a second driving mode.

FIG. 13A is a waveform diagram illustrating first and second uplink signals shown in FIG. 9A.

FIG. 13B is a waveform diagram illustrating third and fourth uplink signals shown in FIGS. 9A and 9B.

FIG. 14A is a waveform diagram illustrating a scan control signal, a light emitting control signal, and first and second uplink signals according to some embodiments of the present disclosure.

FIG. 14B is a waveform diagram illustrating a scan control signal, a light emitting control signal, and an uplink signal according to some embodiments of the present disclosure.

FIG. 15A is a plan view illustrating an operation of an input sensor in a first write frame shown in FIG. 14A.

FIG. 15B is a plan view illustrating an operation of an input sensor in a second write frame shown in FIG. 14A.

FIG. 15C is a plan view illustrating an operation of an input sensor in a first write frame shown in FIG. 14B.

FIG. 15D is a plan view illustrating an operation of an input sensor in a second write frame shown in FIG. 14B.

FIG. 16A is a waveform diagram illustrating a scan control signal, a light emitting control signal, and first and second uplink signals according to some embodiments of the present disclosure.

FIG. 16B is a waveform diagram illustrating a scan control signal, a light emitting control signal, and an uplink signal according to some embodiments of the present disclosure.

FIG. 17A is a waveform diagram illustrating a scan control signal, a light emitting control signal, and first and second uplink signals according to some embodiments of the present disclosure.

FIG. 17B is a waveform diagram illustrating a scan control signal, a light emitting control signal, and an uplink signal according to some embodiments of the present disclosure.

DETAILED DESCRIPTION

In the specification, the expression that a first component (or region, layer, part, portion, etc.) is “on”, “connected with”, or “coupled with” a second component means that the first component is directly on, connected with, or coupled with the second component or means that a third component is interposed therebetween.

Like reference numerals refer to like elements. Also, in the drawings, the thicknesses, the ratios, and the dimensions of the elements may be exaggerated for effective description of technical contents. The expression “and/or” includes one or more combinations which associated components are capable of defining.

Although the terms “first,” “second,” etc. may be used herein in describing various elements, such elements should not be construed as being limited by these terms. These terms are only used to distinguish one element from another element. For example, a first element could be termed a second element without departing from the scope of the claims of the present disclosure, and similarly a second element could be termed a first element. The singular forms are intended to include the plural forms unless the context clearly indicates otherwise.

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Also, the terms “under”, “below”, “on”, “above”, etc. are used to describe the correlation of components illustrated in drawings. These terms are relative concepts and are described on the basis of the directions shown in the drawings.

It will be further understood that the terms “comprises”, “includes”, “have”, etc. specify the presence of stated features, numbers, steps, operations, elements, components, or a combination thereof but do not preclude the presence or addition of one or more other features, numbers, steps, operations, elements, components, or a combination thereof.

Unless otherwise defined, all terms (including technical terms and scientific terms) used in the specification have the same meaning as commonly understood by one skilled in the art to which the present disclosure belongs. Furthermore, terms such as terms defined in the dictionaries commonly used should be interpreted as having a meaning consistent with the meaning in the context of the related technology, and should not be interpreted in ideal or overly formal meanings unless explicitly defined herein.

Hereinafter, aspects of some embodiments of the present disclosure will be described in more detail with reference to accompanying drawings.

FIG. 1 is a perspective view illustrating an electronic device and an input device according to some embodiments of the present disclosure.

Referring to FIG. 1, an electronic device **1000** may be a device activated according to an electrical signal. For example, the electronic device **1000** may be, but is not limited to, a mobile phone, a tablet, a car navigation system, a game console, a wearable device, or any other suitable electronic device having display functionality. FIG. 1 illustrates that the electronic device **1000** is a mobile phone.

An active area **1000A** and a non-active area **1000NA** may be defined in the electronic device **1000**. The electronic device **1000** may display images at the active area **1000A**. The active area **1000A** may include a surface defined by a first direction **DR1** and a second direction **DR2**. The non-active area **1000NA** may surround the active area **1000A**.

The thickness direction of the electronic device **1000** may be parallel to a third direction **DR3** intersecting or normal with respect to a plane defined by the first direction **DR1** and the second direction **DR2**. Thus, front surfaces (or upper surfaces) and rear surfaces (or lower surfaces) of members making up the electronic device **1000** may be defined with respect to the third direction **DR3**.

The electronic device **1000** may detect inputs applied from the outside of the electronic device **1000**. The external inputs may include various types of external inputs such as a part of the body of a user, light, heat, pressure, etc.

The electronic device **1000** shown in FIG. 1 may detect an input by a touch of the user and an input by an input device **2000**. The input device **2000** may refer to a device except for the body of the user. The input by the input device **2000** may be referred to as a first input, and the input by the touch of the user may be referred to as a second input. For example, the input device **2000** may be an active pen, a stylus pen, a touch pen, or an electronic pen. Hereinafter, the case where the input device **2000** is the active pen will be described as an example.

The electronic device **1000** and the input device **2000** may perform bidirectional communication. The electronic device **1000** may provide an uplink signal to the input device **2000**. For example, the uplink signal may include, but is not particularly limited to, a synchronization signal or information of the electronic device **1000**. The input device **2000** may provide a downlink signal to the electronic device **1000**.

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The downlink signal may include a synchronization signal or state information of the input device **2000**. For example, the downlink signal may include, but is not particularly limited to, coordinate information of the input device **2000**, battery information of the input device **2000**, slope information of the input device **2000**, various pieces of information stored in the input device **2000**, and/or the like. The uplink signal and the downlink signal will be described below.

FIG. 2 is a perspective view illustrating an electronic device and an input device according to some embodiments of the present disclosure. In describing FIG. 2, the same reference numerals are assigned to the same components described with reference to FIG. 1, and thus some description thereof may be omitted.

Referring to FIG. 2, an electronic device **1000F** (e.g., a foldable electronic device similar to, or the same as, the electronic device **1000** illustrated in FIG. 1) may display images at an active area **1000AF**. FIG. 2 illustrates that the electronic device **1000F** is folded at a certain angle. In a state where the electronic device **1000F** is unfolded, the active area **1000AF** may include a plane defined by a first direction **DR1** and a second direction **DR2**. The electronic device **1000F** may further include a non-active area **1000NAF** adjacent to the active area **1000AF**.

The active area **1000AF** may include a first active area **1000A1**, a second active area **1000A2**, and a third active area **1000A3**. The first active area **1000A1**, the second active area **1000A2**, and the third active area **1000A3** may be sequentially defined in the first direction **DR1**. The second active area **1000A2** may be bent about a folding axis **FX** extending along the second direction **DR2**. Thus, the first active area **1000A1** and the third active area **1000A3** may be referred to as non-folding areas, and the second active area **1000A2** may be referred to as a folding area.

When the electronic device **1000F** is folded, the first active area **1000A1** and the third active area **1000A3** may face each other. Thus, in a state where the electronic device **1000F** is fully folded, the active area **1000AF** may not be exposed to the outside, which may be referred to as “in-folding”. However, this is merely illustrative, and the operation of the electronic device **1000F** is not limited thereto.

For example, according to some embodiments of the present disclosure, when the electronic device **1000F** is folded, the first active area **1000A1** and the third active area **1000A3** may be opposite to each other. Thus, in a state where the electronic device **1000F** is folded, the active area **1000AF** may be exposed to the outside, which may be referred to as “out-folding”.

The electronic device **1000F** may perform only any one of an in-folding operation or an out-folding operation. Alternatively, the electronic device **1000F** may perform both the in-folding operation and the out-folding operation. In this case, the same area of the electronic device **1000F**, for example, the second active area **1000A2** may be folded inwardly and outwardly.

One folding area and two non-folding areas are illustrated as an example in FIG. 2, but the number of folding areas and the number of non-folding areas are not limited thereto. For example, the electronic device **1000F** may include a plurality of non-folding areas, the number of which is greater than two, and a plurality of folding areas arranged between non-folding areas adjacent to each other. For example, according to some embodiments, the electronic device **1000F** may include three or more non-folding areas, and two or more folding areas arranged between the non-folding areas.

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The case where the folding axis **FX** extends in the second direction **DR2** is illustrated as an example, but embodiments according to the present disclosure are not limited thereto. For example, the folding axis **FX** may extend in a direction parallel to the first direction **DR1**. In this case, the first active area **1000A1**, the second active area **1000A2**, and the third active area **1000A3** may be sequentially arranged along the second direction **DR2**.

The active area **1000AF** may be overlapped with at least one electronic module. For example, the at least one electronic module may include a camera module, a proximity illumination sensor, and the like. The at least one electronic module may receive an external input delivered through the active area **1000AF** or may provide an output through the active area **1000AF**. A portion of the active area **1000AF** overlapped with the camera module, the proximity illumination sensor, and the like may have transmissivity higher than another portion of the active area **1000AF**. Thus, an area where a plurality of electronic modules will be arranged is not provided to the non-active area **1000NAF**. As a result, the ratio of the area of the active area **1000AF** to the front of the electronic device **1000F** may increase, and the ratio of the area of the non-active area **1000NAF** to the front of the electronic device **1000F** may decrease.

The electronic device **1000F** and an input device **2000** may perform bidirectional communication. The electronic device **1000F** may provide an uplink signal to the input device **2000**. The input device **2000** may provide a downlink signal to the electronic device **1000F**. The electronic device **1000F** may detect coordinates of the input device **2000** using a signal provided from the input device **2000**.

FIG. 3 is a block diagram schematically illustrating an electronic device and an input device according to some embodiments of the present disclosure.

Referring to FIG. 3, an electronic device **1000** may include a display panel **100**, an input sensor **200**, a panel driver **100C**, a sensor controller **200C**, and a main controller **1000C**.

The display panel **100** may be a component which generates or displays images. The display panel **100** may be a light emitting display panel. For example, the display panel **100** may be an organic light emitting display panel, an inorganic light emitting display panel, a quantum dot display panel, a micro-LED display panel, or a nano-LED display panel.

The input sensor **200** may be located on the display panel **100**. The input sensor **200** may sense an external input applied from the outside. The input sensor **200** may sense a first input by the input device **2000** and a second input by a body (e.g., a finger, etc.) **3000** of the user.

The main controller **1000C** may control the overall operation of the electronic device **1000**. For example, the main controller **1000C** may control operations of the panel driver **100C** and the sensor controller **200C**. The main controller **1000C** may include at least one microprocessor, and the main controller **1000C** may be referred to as a host.

The panel driver **100C** may control the display panel **100**. The main controller **1000C** may further include a graphics controller. The panel driver **100C** may receive an image signal **RGB** and a first control signal **D-CS** from the main controller **1000C**. The first control signal **D-CS** may include various signals. For example, the first control signal **D-CS** may include a vertical synchronization signal, a horizontal synchronization signal, a main clock, a data enable signal, and the like. The panel driver **100C** may generate various control signals (e.g., a start signal and a clock signal) for

controlling timing for providing a signal to the display panel **100** based on the first control signal D-CS.

The sensor controller **200C** may control the input sensor **200**. The sensor controller **200C** may receive a second control signal I-CS from the main controller **1000C**. The second control signal I-CS may include a mode determination signal for determining a driving mode of the sensor controller **200C** and a clock signal. The sensor controller **200C** may operate in a first mode for detecting the first input by the input device **2000** based on the second control signal I-CS or a second mode for detecting the second input by the body **3000** of the user. The sensor controller **200C** may control the input sensor **200** in the first mode or the second mode, which will be described below, based on the mode determination signal.

The sensor controller **200C** may calculate coordinate information of the first input or the second input based on the signal received from the input sensor **200** and may provide the main controller **1000C** with a coordinate signal I-SS including the coordinate information. The main controller **1000C** may execute an operation corresponding to the user input based on the coordinate signal I-SS. For example, the main controller **1000C** may operate the panel driver **100C** such that a new application image is displayed on the display panel **100** based on the coordinate signal I-SS.

The input device **2000** may include a housing **2100**, a power source **2200**, a pen controller **2300**, a communication module **2400**, and a pen electrode **2500**. However, the components making up the input device **2000** are not limited to the listed components. For example, the input device **2000** may further include an electrode switch for converting into a signal transmission mode or a signal reception mode, a pressure sensor for sensing pressure, a memory for storing certain information, a rotation sensor for sensing rotation, a haptic feedback component (configured to, for example, provide vibration feedback to the user), or any other suitable functionality or component according to the design of the input device **2000** and the electronic device **1000** (and/or the electronic device **1000F**).

The housing **2100** may have a pen shape, and a receiving space may be formed in the housing **2100**. The power source **2200**, the pen controller **2300**, the communication module **2400**, and the pen electrode **2500** may be received in the receiving space defined in the housing **2100**.

The power source **2200** may supply power to the pen controller **2300**, the communication module **2400**, or the like in the input device **2000**. The power source **2200** may include a battery or a high capacity capacitor.

The pen controller **2300** may control an operation of the input device **2000**. The pen controller **2300** may be an application-specific integrated circuit (ASIC). The pen controller **2300** may be configured to operate according to the designed program.

The communication module **2400** may include a transmit circuit **2410** and a receive circuit **2420**. The transmit circuit **2410** may output a downlink signal DLS to the input sensor **200**. The receive circuit **2420** may receive the uplink signal ULS provided from the input sensor **200**. The transmit circuit **2410** may receive the signal provided from the pen controller **2300** to convert the received signal into a signal capable of being sensed by the input sensor **200**, and the receive circuit **2420** may modulate the signal provided from the input sensor **200** into a signal capable of being processed by the pen controller **2300**.

The pen electrode **2500** may be electrically connected with the communication module **2400**. A part of the pen electrode **2500** may protrude from the housing **2100**. Alter-

natively, the input device **2000** may further include a cover housing which covers the pen electrode **2500** exposed from the housing **2100**. Alternatively, the pen electrode **2500** may be embedded in the housing **2100**.

FIG. **4a** is a cross-sectional view of an electronic device according to some embodiments of the present disclosure.

Referring to FIG. **4a**, an electronic device **1000** may include a display panel **100** and an input sensor **200**. The display panel **100** may include a base layer **110**, a circuit layer **120**, a light emitting element layer **130**, and an encapsulation layer **140**.

The base layer **110** may be a member which provides a base surface on which the circuit layer **120** is located. The base layer **110** may be a glass substrate, a metal substrate, or a polymer substrate. However, an embodiment is not limited thereto, and the base layer **110** may be an inorganic layer, an organic layer, or a composite material layer.

The base layer **110** may have a multi-layered structure. For example, the base layer **110** may include a first synthetic resin layer, a silicon oxide (SiO_x) layer located on the first synthetic resin layer, an amorphous silicon (a-Si) layer located on the silicon oxide layer, and a second synthetic resin layer located on the amorphous silicon layer. The silicon oxide layer and the amorphous silicon layer may be referred to as a “base barrier layer”.

Each of the first and second synthetic resin layers may include a polyimide-based resin. Furthermore, each of the first and second synthetic resin layers may include at least one of an acrylate-based resin, a methacrylate-based resin, a polyisoprene-based resin, a vinyl-based resin, an epoxy-based resin, a urethane-based resin, a cellulose-based resin, a siloxane-based resin, a polyamide-based resin, or a perylene-based resin. Meanwhile, the expression “~~-based resin” in the specification refers to including the functional group of “~”.

The circuit layer **120** may be located on the base layer **110**. The circuit layer **120** may include an insulating layer, a semiconductor pattern, a conductive pattern, a signal line, and the like. An insulating layer, a semiconductor layer, and a conductive layer may be formed on the base layer **110** in a scheme such as coating or deposition and may then be selectively patterned through a plurality of photolithography processes. Thereafter, the semiconductor pattern, the conductive pattern, and the signal line included in the circuit layer **120** may be formed.

The light emitting element layer **130** may be located on the circuit layer **120**. The light emitting element layer **130** may include a light emitting element. For example, the light emitting element layer **130** may be an organic light emitting material, a quantum dot, a quantum rod, a micro-LED, or a nano-LED.

The encapsulation layer **140** may be located on the light emitting element layer **130**. The encapsulation layer **140** may protect the light emitting element layer **130** from moisture, oxygen, and foreign substances such as dust particles.

The input sensor **200** may be formed on the display panel **100** through consecutive processes. In this case, it may be represented that the input sensor **200** is directly located on the display panel **100**. The expression “directly located” or “directly arranged” may mean that a third component is not located between the input sensor **200** and the display panel **100**. In other words, a separate adhesive member may not be located between the input sensor **200** and the display panel **100**. Alternatively, the input sensor **200** may be coupled to

the display panel **100** by means of an adhesive member. The adhesive member may include a typical adhesive or sticking agent.

FIG. **4b** is a cross-sectional view of an electronic device according to some embodiments of the present disclosure.

Referring to FIG. **4B**, an electronic device **1000-1** may include a display panel **100-1** and an input sensor **200-1**. The display panel **100-1** may include a base substrate **110-1**, a circuit layer **120-1**, a light emitting element layer **130-1**, an encapsulation substrate **140-1**, and a coupling member **150-1**.

Each of the base substrate **110-1** and the encapsulation substrate **140-1** may be, but are not particularly limited to, a glass substrate, a metal substrate, a polymer substrate, or the like.

The coupling member **150-1** may be located between the base substrate **110-1** and the encapsulation substrate **140-1**. The coupling member **150-1** may couple the encapsulation substrate **140-1** to the base substrate **110-1** or the circuit layer **120-1**. The coupling member **150-1** may include an inorganic material or an organic material. For example, the inorganic material may include a frit seal, and the organic material may include a photo-curable material or a photo-plastic resin. However, a material making up the coupling member **150-1** is not limited to the above example.

The input sensor **200-1** may be directly located on the encapsulation substrate **140-1**. The expression “directly located” or “directly arranged” may mean that a third component is not located between the input sensor **200-1** and the encapsulation substrate **140-1**. In other words, a separate adhesive member may not be located between the input sensor **200-1** and the display panel **100-1**. However, embodiments according to the present disclosure are not limited thereto, and according to some embodiments, an adhesive layer may be further located between the input sensor **200-1** and the encapsulation substrate **140-1**.

FIG. **5** is a cross-sectional view of an electronic device according to some embodiments of the present disclosure. In describing FIG. **5**, the same reference numerals are assigned to the same components described with reference to FIG. **4A**, and thus some repetitive description thereof may be omitted.

Referring to FIG. **5**, at least one inorganic layer may be formed on an upper surface of a base layer **110**. The inorganic layer may include at least one of aluminum oxide, titanium oxide, silicon oxide, silicon oxynitride, silicon nitride, zirconium oxide, or hafnium oxide. The inorganic layer may be formed of multiple layers. The multiple inorganic layers may make up a barrier layer and/or a buffer layer. According to some embodiments, a display panel **100** is illustrated as including a buffer layer BFL.

The buffer layer BFL may relatively improve a bonding force between the base layer **110** and a semiconductor pattern. The buffer layer BFL may include a silicon oxide layer and a silicon nitride layer, and the silicon oxide layer and the silicon nitride layer may be alternately laminated.

The semiconductor pattern may be located on the buffer layer BFL. The semiconductor pattern may include polysilicon. However, embodiments according to the present disclosure are not limited thereto, and the semiconductor pattern may include amorphous silicon, low-temperature polycrystalline silicon, or oxide semiconductor.

FIG. **5** illustrates only a portion of the semiconductor pattern, and the semiconductor pattern may be further located in other regions. Semiconductor patterns may be arranged across pixels in a specific arrangement. An electrical property of the semiconductor pattern may vary

depending on whether it is doped, and the manner in which it is doped. The semiconductor pattern may include a first area having high conductivity and a second area having low conductivity. The first area may be doped with an N-type dopant or a P-type dopant. A P-type transistor may include a doping area doped with the P-type dopant, and an N-type transistor may include a doping area doped with the N-type dopant. The second area may be an undoped region or may be doped at a low concentration compared to the first area.

The first area may be greater in conductivity than the second area and may substantially serve as an electrode or a signal line. The second area may substantially correspond to a channel area of a transistor. In other words, a part of the semiconductor pattern may be a channel part of a transistor, another part thereof may be a source or a drain of the transistor, and another part thereof may be a connection electrode or a connection signal line.

Each of pixels may have an equivalent circuit including seven transistors, one capacitor, and a light emitting element, and the equivalent circuit of the pixel may be modified in various forms. One transistor **100PC** and one light emitting element **100PE** included in the pixel are illustrated as an example in FIG. **5**.

The transistor **100PC** may include a source **SC1**, a channel part **A1**, a drain **D1**, and a gate **G1**. The source **SC1**, the channel part **A1**, and the drain **D1** may be formed from the semiconductor pattern. The source **SC1** and the drain **D1** may extend in opposite directions from the channel part **A1** on the cross-section. FIG. **5** illustrates a part of a connection signal line **SCL** formed from the semiconductor pattern. According to some embodiments, the connection signal line **SCL** may be electrically connected with the drain **D1** of the transistor **100PC** on the plane.

A first insulating layer **10** may be located on a buffer layer BFL. The first insulating layer **10** may be overlapped with a plurality of pixels in common and may cover the semiconductor pattern. The first insulating layer **10** may be an inorganic layer and/or an organic layer and may have a single- or multi-layered structure. The first insulating layer **10** may include at least one of aluminum oxide, titanium oxide, silicon oxide, silicon nitride, silicon oxynitride, zirconium oxide, or hafnium oxide. According to some embodiments, the first insulating layer **10** may be a single silicon oxide layer. As well as the first insulating layer **10**, an insulating layer of a circuit layer **120** to be described below may be an inorganic layer and/or an organic layer and may have a single- or multi-layered structure. The inorganic layer may include, but is not limited to, at least one of the materials described above.

The gate **G1** may be located on the first insulating layer **10**. The gate **G1** may be a part of a metal pattern. The gate **G1** may be overlapped with the channel part **A1**. The gate **G1** may function as a mask in the process of doping the semiconductor pattern.

A second insulating layer **20** may be located on the first insulating layer **10** and may cover the gate **G1**. The second insulating layer **20** may be overlapped with pixels in common. The second insulating layer **20** may be an inorganic layer and/or an organic layer and may have a single- or multi-layered structure. The second insulating layer **20** may include at least one of silicon oxide, silicon nitride, or silicon oxynitride. According to some embodiments, the second insulating layer **20** may have a multi-layered structure including a silicon oxide layer and a silicon nitride layer.

A third insulating layer **30** may be located on the second insulating layer **20**. The third insulating layer **30** may have a single- or multi-layered structure. For example, the third

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insulating layer **30** may have a multi-layered structure including a silicon oxide layer and a silicon nitride layer.

A first connection electrode **CNE1** may be located on the third insulating layer **30**. The first connection electrode **CNE1** may be connected with the connection signal line **SCL** through a contact hole **CNT-1** penetrating the first, second, and third insulating layers **10**, **20**, and **30**.

A fourth insulating layer **40** may be located on the third insulating layer **30**. The fourth insulating layer **40** may be a single silicon oxide layer. A fifth insulating layer **50** may be located on the fourth insulating layer **40**. The fifth insulating layer **50** may be an organic layer.

A second connection electrode **CNE2** may be located on the fifth insulating layer **50**. The second connection electrode **CNE2** may be connected with the first connection electrode **CNE1** through a contact hole **CNT-2** penetrating the fourth insulating layer **40** and the fifth insulating layer **50**.

A sixth insulating layer **60** may be located on the fifth insulating layer **50** and may cover the second connection electrode **CNE2**. The sixth insulating layer **60** may be an organic layer.

A light emitting element layer **130** may be located on the circuit layer **120**. The light emitting element layer **130** may include a light emitting element **100PE**. For example, the light emitting element layer **130** may include an organic light emitting material, an inorganic light emitting material, a quantum dot, a quantum rod, a micro-LED, or a nano-LED. Hereinafter, an example in which the light emitting element **100PE** is an organic light emitting element will be described, but embodiments according to the present disclosure are not specifically limited thereto.

The light emitting element **100PE** includes a first electrode **AE**, a light emitting layer **EL**, and a second electrode **CE**. The first electrode **AE** may be located on the sixth insulating layer **60**. The first electrode **AE** may be connected with the second connection electrode **CNE2** through a contact hole **CNT-3** penetrating the sixth insulating layer **60**.

A pixel definition layer **70** may be located on the sixth insulating layer **60** and may cover a part of the first electrode **AE**. An opening **70-OP** may be defined in the pixel definition layer **70**. The opening **70-OP** of the pixel definition layer **70** may expose at least a part of the first electrode **AE**.

An active area **1000A** (refer to FIG. 1) may include a light emitting area **PXA** and a non-light emitting area **NPXA** adjacent to the light emitting area **PXA**. The non-light emitting area **NPXA** may surround the light emitting area **PXA**. According to some embodiments, the light emitting area **PXA** is defined to correspond to a partial area of the first electrode **AE**, which is exposed by the opening **70-OP**.

The light emitting layer **EL** may be located on the first electrode **AE**. The light emitting layer **EL** may be located in an area corresponding to the opening **70-OP**. In other words, the light emitting layer **EL** may be separately arranged in each of the pixels. When the light emitting layers **EL** are separately arranged in the pixels, each of the light emitting layers **EL** may emit light of at least one of a blue color, a red color, or a green color. However, embodiments according to the present disclosure are not limited thereto. The light emitting layer **EL** may be connected with the pixels to be provided in common. In this case, the light emitting layer **EL** may provide blue light or may provide white light.

The second electrode **CE** may be located on the light emitting layer **EL**. The second electrode **CE** may be in the shape of integration and may be arranged in common in a plurality of pixels.

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According to some embodiments, a hole control layer may be located between the first electrode **AE** and the light emitting layer **EL**. The hole control layer may be arranged in common in the light emitting area **PXA** and the non-light emitting area **NPXA**. The hole control layer may include a hole transport layer and may further include a hole injection layer. An electron control layer may be located between the light emitting layer **EL** and the second electrode **CE**. The electron control layer may include an electron transport layer and may further include an electron injection layer. The hole control layer and the electron control layer may be formed in common in the plurality of pixels using an open mask.

The encapsulation layer **140** may be located on the light emitting element layer **130**. An encapsulation layer **140** may include an inorganic layer, an organic layer, and an inorganic layer sequentially laminated, and layers making up the encapsulation layer **140** are not limited thereto.

The inorganic layers may protect the light emitting element layer **130** from moisture and oxygen, and the organic layer may protect the light emitting element layer **130** from foreign substances such as dust particles. The inorganic layers may include a silicon nitride layer, a silicon oxynitride layer, a silicon oxide layer, a titanium oxide layer, an aluminum oxide layer, or the like. The organic layer may include, but is not limited to, an acrylic-based organic layer.

The input sensor **200** may be formed on the display panel **100** through consecutive processes. In this case, it may be represented that the input sensor **200** is directly located on the display panel **100**. The expression "directly located" or "directly arranged" may mean that a third component is not located between the input sensor **200** and the display panel **100**. In other words, a separate adhesive member may not be located between the input sensor **200** and the display panel **100**. Alternatively, the input sensor **200** may be coupled to the display panel **100** by means of an adhesive member. The adhesive member may include a typical adhesive or sticking agent.

The input sensor **200** may include a base insulating layer **201**, a first conductive layer **202**, a sensing insulating layer **203**, a second conductive layer **204**, and a cover insulating layer **205**.

The base insulating layer **201** may be an inorganic layer including at least any one of silicon nitride, silicon oxynitride, and silicon oxide. Alternatively, the base insulating layer **201** may be an organic layer including an epoxy resin, an acrylic resin, or an imide-based resin. The base insulating layer **201** may have a single-layered structure or may be a multi-layered structure in which a plurality of layers are laminated along the third direction **DR3**.

Each of the first conductive layer **202** and the second conductive layer **204** may have a single-layered structure or may have a multi-layered structure in which a plurality of layers are laminated along the third direction **DR3**.

A conductive layer of a single-layered structure may include a metal layer or a transparent conductive layer. The metal layer may include molybdenum, silver, titanium, copper, aluminum, or an alloy thereof. The transparent conductive layer may include transparent conductive oxide such as indium tin oxide (**ITO**), indium zinc oxide (**IZO**), zinc oxide (**ZnO**), or indium zinc tin oxide (**IZTO**). In addition, the transparent conductive layer may include conductive polymer such as **PEDOT**, metal nanowire, graphene, or the like.

The conductive layer of the multi-layered structure may include metal layers. The metal layers may have, for example, a three-layered structure of titanium/aluminum/

titanium. The conductive layer of the multi-layered structure may include at least one metal layer and at least one transparent conductive layer.

At least any one of the sensing insulating layer **203** and the cover insulating layer **205** may include an inorganic layer. The inorganic layer may include at least one of aluminum oxide, titanium oxide, silicon oxide, silicon nitride, silicon oxynitride, zirconium oxide, or hafnium oxide.

At least any one of the sensing insulating layer **203** and the cover insulating layer **205** may include an organic layer. The organic layer may include at least any one of an acrylic-based resin, a methacrylic-based resin, polyisoprene, a vinyl-based resin, an epoxy-based resin, a urethane-based resin, a cellulose-based resin, a siloxane-based resin, a polyimide-based resin, a polyamide-based resin, and a perylene-based resin.

Parasitic capacitance C_b may be generated between the input sensor **200** and the second electrode CE. The closer the distance between the input sensor **200** and the second electrode CE, the more the value of the parasitic capacitance C_b may increase. The larger the parasitic capacitance C_b , the more the ratio of the variation in capacitance to a reference value may decrease. The variation in the capacitance may mean a change in capacitance, which occurs before and after an input by an input means, for example, an input device **2000** (refer to FIG. 3) or a body **3000** (refer to FIG. 3) of a user.

A sensor controller **200C** (refer to FIG. 3) which processes the signal sensed from the input sensor **200** may perform a leveling operation for removing a value corresponding to the parasitic capacitance C_b from the sensed signal. As the ratio of the variation in capacitance to the reference value may increase by the leveling operation, sensing sensitivity may be relatively improved.

FIG. 6 is a block diagram of a display panel and a panel driver according to some embodiments of the present disclosure.

Referring to FIG. 6, a display panel **100** may include a plurality of scan lines SL_1 to SL_n , a plurality of data lines DL_1 to DL_m , a plurality of light emitting control lines EL_1 to EL_n , and a plurality of pixels PX. Each of the plurality of pixels PX may be connected with a corresponding data line among the plurality of data lines DL_1 to DL_m and may be connected with a corresponding scan line among the plurality of scan lines SL_1 to SL_n and a corresponding light emitting control line among the plurality of light emitting control lines EL_1 to EL_n .

A panel driver **100C** may include a signal control circuit **100C1**, a scan driver **100C2**, a data driver **100C3**, and a light emitting driver **100C4**.

The signal control circuit **100C1** may receive an image signal RGB and a first control signal D-CS from a main controller **1000C** (refer to FIG. 3). The first control signal D-CS may include various signals. For example, the first control signal D-CS may include a vertical synchronization signal, a horizontal synchronization signal, a main clock, a data enable signal, and the like.

The signal control circuit **100C1** may generate a scan control signal CONT1, a data control signal CONT2, and a light emitting control signal CONT3 based on the first control signal D-CS. The signal control circuit **100C1** may provide the scan control signal CONT1 to the scan driver **100C2**, may provide the data control signal CONT2 to the data driver **100C3**, and may provide the light emitting control signal CONT3 to the light emitting driver **100C4**. Furthermore, the signal control circuit **100C1** may output

image data D-RGB, which is obtained by processing the image signal RGB to suit an operating condition of the display panel **100**, to the data driver **100C3**.

The scan driver **100C2** may drive the plurality of scan lines SL_1 to SL_n in response to the scan control signal CONT1. The scan control signal CONT1 may include a scan start signal FLM (refer to FIG. 14A), a scan clock signal CLK (refer to FIG. 14A), or the like. According to some embodiments of the present disclosure, the scan driver **100C2** may be formed in the same process as the circuit layer **120** (refer to FIG. 5) in the display layer **100**, but embodiments according to the present disclosure are not limited thereto. For example, the scan driver **100C2** may be implemented as an integrated circuit (IC) to be directly mounted on a certain region of the display layer **100** or be mounted on a separate printed circuit board in a chip on film (COF) manner to be electrically connected with the display panel **100**.

The data driver **100C3** may output data signals for driving the plurality of data lines DL_1 to DL_m in response to the data control signal CONT2 and the image data D-RGB from the signal control circuit **100C1**. The data driver **100C3** may be implemented as an IC to be directly mounted on a certain region of the display layer **100** or be mounted on a separate printed circuit board in a COF manner to be electrically connected with the display panel **100**, but not particularly limited thereto. For example, the data driver **100C3** may be formed in the same process as the circuit layer **120** in the display panel **100**.

The light emitting driver **100C4** may drive the plurality of light emitting control lines EL_1 to EL_n in response to the light emitting control signal CONT3. The light emitting control signal CONT3 may include a light emitting start signal E_FLM (refer to FIG. 14A), a light emitting clock signal E_CLK (refer to FIG. 14A), or the like. According to some embodiments of the present disclosure, the light emitting driver **100C4** may be formed in the same process as the circuit layer **120** in the display layer **100**, but not limited thereto. For example, the light emitting driver **100C4** may be implemented as an integrated circuit (IC) to be directly mounted on a certain region of the display layer **100** or be mounted on a separate printed circuit board in a chip on film (COF) manner to be electrically connected with the display panel **100**.

According to some embodiments of the present disclosure, the light emitting driver **100C4** may have a component independent of the scan driver **100C2**, but embodiments according to the present disclosure are not limited thereto. For example, the scan driver **100C2** and the light emitting driver **100C4** may be implemented into one integrated circuit.

FIG. 7 is a conceptual diagram illustrating operations of a first mode and a second mode according to some embodiments of the present disclosure.

Referring to FIGS. 3 and 7, a sensor controller **200C** may operate in a first mode MD1 for detecting a first input by an input device **2000** or a second mode MD2 for detecting a second input by a body **3000** of a user.

The first mode MD1 may include a first interval PU1 and a second interval PS1. The second interval PS1 may proceed after the first interval PU1. The first interval PU1 may be an uplink interval where an uplink signal ULS is able to be transmitted to an input sensor **200**. The second interval PS1 may be a downlink interval where a downlink signal DLS provided from the input device **2000** is able to be received

through the input sensor **200**. The input sensor **200** may sense the first input of the input device **2000** based on the downlink signal DLS.

The input device **2000** may provide the downlink signal DLS to the sensor controller **200C** during the downlink interval DLM.

The sensor controller **200C** may operate in the second mode MD2, after the first mode MD1 is ended. The first mode MD1 and the second mode MD2 may be repeated with each other.

The second mode MD2 may include a first interval PU2 and a second interval PS2. The second interval PS2 may proceed after the first interval PU2. The first interval PU2 may be an uplink interval where an uplink signal ULS is able to be transmitted to the input sensor **200**. The second interval PS2 may be an interval where the second input is detected by the body **3000** of the user.

The input device **2000** may provide the input sensor **200** with a response signal to the uplink signal ULS. When receiving the response signal sensed by the input sensor **200** in the first interval PU1 or PU2, the sensor controller **200C** may operate in the second interval PS1 of the first model MD1. When not receiving the response signal from the input device **2000** in the first interval PU2, the sensor controller **200C** may operate in the second interval PS2 of the second model MD2. Thus, the input sensor **200** may periodically monitor whether there is sensing of the input device **2000** and may easily sense the first input by the input device **2000**. However, this is merely illustrative, and the operation of the electronic device **1000** is not particularly limited thereto.

FIG. **8** is a block diagram of an input sensor and a sensor controller according to some embodiments of the present disclosure.

Referring to FIG. **8**, a sensing area **200A** and a non-sensing area **200N** may be defined in an input sensor **200**. The sensing area **200A** may be an area which is activated according to an electrical signal. For example, the sensing area **200A** may be an area where an input is sensed. The sensing area **200A** may be overlapped with an active area **1000A** (refer to FIG. **1**) of an electronic device **1000** (refer to FIG. **1**). The non-sensing area **200N** may surround the sensing area **200A**. The non-sensing area **200N** may be overlapped with a non-active area **1000NA** (refer to FIG. **1**) of the electronic device **1000** (refer to FIG. **1**).

The input sensor **200** may include a plurality of transmit electrodes **210** and a plurality of receive electrodes **220**. Each of the plurality of transmit electrodes **210** may extend along the first direction DR1, and the plurality of transmit electrodes **210** may be arranged spaced apart from each other in the second direction DR2. Each of the plurality of receive electrodes **220** may extend along the second direction DR2, and the plurality of receive electrodes **220** may be arranged to be spaced apart from each other in the first direction DR1.

The plurality of receive electrodes **220** may intersect the plurality of transmit electrodes **210** to be insulated. Each of the plurality of transmit electrodes **210** and the plurality of receive electrodes **220** may have a bar shape or a stripe shape (e.g., elongated linearly in one direction with relatively short sides in the perpendicular direction). The plurality of transmit electrodes **210** and the plurality of receive electrodes **220**, each of which has such a shape, may relatively improve sensing characteristics of consecutive linear inputs. However, the shape of each of the plurality of transmit electrodes **210** and the plurality of receive electrodes **220** is not limited thereto.

A sensor controller **200C** may receive a second control signal I-CS from a main controller **1000C** (refer to FIG. **3**) and may provide a coordinate signal I-SS to a main controller **1000C** (refer to FIG. **3**).

The sensor controller **200C** may include a sensor control circuit **200C1**, a signal generation circuit **200C2**, an input detection circuit **200C3**, and a switching circuit **200C4**. The sensor control circuit **200C1**, the signal generation circuit **200C2**, and the input detection circuit **200C3** may be implemented in a single chip, or some of the sensor control circuit **200C1**, the signal generation circuit **200C2**, and the input detection circuit **200C3** and the others may be implemented in different chips.

The sensor control circuit **200C1** may control operations of the signal generation circuit **200C2** and the switching circuit **200C4** and may calculate coordinates of an external input from a driving signal received from the input detection circuit **200C3** or may analyze information, transmitted from an input device **2000** (refer to FIG. **3**), from a modulation signal received from the input detection circuit **200C3**. The sensor control circuit **200C1** may define the sensing area **200A** of the input sensor **200** into a plurality of areas. The sensor control circuit **200C1** may provide a first uplink signal to some of the plurality of areas and may provide a second uplink signal having a reverse phase of the first uplink signal to the others. This will be described in more detail below.

The signal generation circuit **200C2** may provide the input sensor **200** with an output signal called a transmit signal. The signal generation circuit **200C2** may output an output signal matched with an operation mode to the input sensor **200**.

The input detection circuit **200C3** may convert an analog type of receive signal (or sensing signal) received from the input sensor **200** into a digital signal. The input detection circuit **200C3** may amplify and filter the receive signal. The input detection circuit **200C3** may convert the subsequently filtered signal into a digital signal.

The switching circuit **200C4** may selectively control an electrical connection relationship between the input sensor **200** and the signal generation circuit **200C2** and/or the input detection circuit **200C3** under control of the sensor control circuit **200C1**. The switching circuit **200C4** may connect a group of any one of the plurality of transmit electrodes **210** and the plurality of receive electrodes **220** with the signal generation circuit **200C2** or may connect each of the plurality of transmit electrodes **210** and the plurality of receive electrodes **220** with the signal generation circuit **200C2**, under control of the sensor control circuit **200C1**. Alternatively, the switching circuit **200C4** may connect one group or all of the plurality of transmit electrodes **210** and the plurality of receive electrodes **220** with the input detection circuit **200C3**.

FIGS. **9A** and **9B** are waveform diagrams illustrating uplink signals according to some embodiments of the present disclosure. FIGS. **10A** to **10D** are plan views illustrating an operation of an input sensor in a first driving mode. FIGS. **11A** and **11B** are plan views illustrating an operation of an input sensor in a first driving mode. FIG. **12** is a plan view illustrating an operation of an input sensor in a second driving mode. FIG. **13A** is a waveform diagram illustrating first and second uplink signals shown in FIG. **9A**. FIG. **13B** is a waveform diagram illustrating third and fourth uplink signals shown in FIGS. **9A** and **9B**.

Referring to FIGS. **3**, **6**, and **9A**, a panel driver **100C** may drive a display panel **100** at a first operating frequency in a first driving mode NM and may drive the display panel **100**

at a second operating frequency in a second driving mode LM. The second operating frequency may be lower than the first operating frequency. For example, the second operating frequency may be a frequency of 1 Hz, 10 Hz, 15 Hz, 30 Hz, or 48 Hz, and the first operating frequency may be a frequency of 60 Hz, 120 Hz, or 240 Hz. As such, an operation mode where the operating frequency of the display panel **100** varies may be defined as a variable frequency mode.

In the first driving mode NM, the display panel **100** may display a first image (e.g., a moving image or the like) during a plurality of frames NDF1, NDF2, NDF3, and NDF4 (e.g., may be referred to as a “first driving frame” or a “normal driving frame”). In the second driving mode LM, the display panel **100** may display a second image (e.g., a still image or the like) during a plurality of frames LDF1 and LDF2 (e.g., may be referred to as a “second driving frame” or a “low-frequency driving frame”). A duration of each of the plurality of second driving frames LDF1 and LDF2 may be greater than a duration of each of the plurality of first driving frames NDF1, NDF2, NDF3, and NDF4.

Each of the plurality of second driving frames LDF1 and LDF2 may include a write frame SF1 (e.g., may be referred to as a “first sub-frame” or a “refresh frame”) and a plurality of holding frames SF2 (e.g., may be referred to as “second sub-frames” or “bias frames”). According to some embodiments of the present disclosure, the write frame SF1 may be the same in duration as each of the plurality of first driving frames NDF1, NDF2, NDF3, and NDF4. Each of the plurality of holding frames SF2 may be the same in duration as each of the plurality of first driving frames NDF1, NDF2, NDF3, and NDF4 and the write frame SF1.

The duration of each of the plurality of first driving frames NDF1, NDF2, NDF3, and NDF4, the duration of the write frame SF1, and the duration of each of the plurality of holding frames SF2 may be determined according to or based on a frequency of a vertical synchronization signal Vsync. A data driver **100C3** may apply a data signal Vdata (e.g., may be referred to as a “normal data signal” or a “valid data signal”) including image information to the display panel **100** during the write frame SF1. The data driver **100C3** may apply a data signal Vdc (e.g., may be referred to as a “black data signal” or a “bias data signal”), which does not include image information, to the display panel **100** during each holding frame SF2. The bias data signal Vdc may be a data signal having a black gray scale or a low gray scale.

The sensor controller **200C** may drive the input sensor **200**. According to some embodiments of the present disclosure, the operating frequency of the input sensor **200** may be synchronized with a first operating frequency of the display panel **100**. When the driving mode of the display panel **100** switches from the first driving mode NM to the second driving mode LM or switches from the second driving mode LM to the first driving mode NM, the operating frequency of the input sensor **200** may be fixed to a specific frequency, for example, the first operating frequency. According to some embodiments of the present disclosure, when the first operating frequency of the display panel **100** is 60 Hz in the first driving mode NM, the operating frequency of the input sensor **200** may also be 60 Hz. Although the second operating frequency of the display panel **100** switches to 10 Hz in the second driving mode LM, the operating frequency of the input sensor **200** may be maintained as 60 Hz.

When the display panel **100** operates in the first driving mode NM, the sensor controller **200C** may transmit a first mode uplink signal (e.g., a first uplink signal ULS1 and a second uplink signal ULS2) to the input sensor **200**. Each of

the first driving frames NDF1 may include an interval corresponding to a first interval PU1 where the first and second uplink signals ULS1 and ULS2 are transmitted. The state where the input sensor **200** operates in the first mode MD1 (refer to FIG. 7) is illustrated as an example in FIG. 9A. However, even when the input sensor **200** operates in a second mode MD2 (refer to FIG. 7), first and second uplink signals ULS1 and ULS2 may be transmitted to the input sensor **200** during a first interval PU2 (refer to FIG. 7).

The second uplink signal ULS2 may be a signal, a phase of which is delayed by 180° from the first uplink signal ULS1. Thus, the first and second uplink signals ULS1 and ULS2 may have inverted phases in the first interval PU1. When the first uplink signal ULS1 has positive polarity (+) in a portion of the first interval PU1, the second uplink signal ULS2 may have negative polarity (-). When the first uplink signal ULS1 has negative polarity (-) in another portion of the first interval PU1, the second uplink signal ULS2 may have positive polarity (+).

Referring to FIGS. 10A to 10D, the input sensor **200** may include a base insulating layer **201**, a plurality of transmit electrodes TE1 to TE10, a plurality of receive electrodes RE1 to RE6, a plurality of trace lines **230**, and a plurality of pads **240**.

The plurality of transmit electrodes TE1 to TE10 and the plurality of receive electrodes RE1 to RE6 may be arranged in the sensing area **200A**. The plurality of trace lines **230** and the plurality of pads **240** may be arranged in the non-sensing area **200N**. **10** transmit electrodes TE1 to TE10 and **6** receive electrodes RE1 to RE6 are illustrated as an example in FIGS. 10A and 10B, but the number of transmit electrodes and the number of receive electrodes are not limited thereto.

Each of the plurality of transmit electrodes TE1 to TE10 and the plurality of receive electrodes RE1 to RE6 may be electrically connected with a corresponding trace line among the plurality of trace lines **230**. A single routing structure where the one trace line **230** is connected with the one transmit electrode TE1 to TE10 and where the one trace line **230** is connected with the one receive electrode RE1 to RE6 is illustrated as an example in FIGS. 10A and 10B, but not particularly limited thereto. For example, the two trace lines **230** may be connected with each of the plurality of receive electrodes RE1 to RE6, and the one trace line **230** may be connected with each of the plurality of transmit electrodes TE1 to TE10. Furthermore, the two trace lines **230** may be connected with each of the plurality of electrodes RE1 to RE6, and the two trace lines **230** may be connected with each of the plurality of receive electrodes RE1 to RE6.

The plurality of pads **240** may be electrically connected with the plurality of trace lines **230**, respectively. The input sensor **200** may be electrically connected with the sensor controller **200C** through the plurality of pads **240**. However, this is merely illustrative, and the plurality of pads **240** according to some embodiments of the present disclosure may be arranged in the display panel **100**. In this case, the plurality of trace lines **230** may be electrically connected with the plurality of pads **240** through contact holes.

Referring to FIG. 10A, the sensing area **200A** of the input sensor **200** may include a first area AR1-1 and a second area AR1-2 in an odd-numbered first driving frame NDF1 of a first driving mode NM.

When the input device **2000** is arranged at a first position, the input sensor **200** may sense first coordinates CP1 corresponding to the first position. The sensor controller **200C** may define the first area AR1-1 based on the first coordinates CP1. The first area AR1-1 may be overlapped with the first coordinates CP1. The first area AR1-1 may be a portion of

the sensing area **200A**, and the second area **AR1-2** may be the rest of the sensing area **200A** except for the first area **AR1-1**. The first and second areas **AR1-1** and **AR1-2** may be defined based on the plurality of transmit electrodes **TE1** to **TE10**. The first uplink signal **ULS1** may be provided to transmit electrodes (e.g., first to sixth transmit electrodes **TE1** to **TE6**) located in the first area **AR1-1**. The second uplink signal **ULS2** may be provided to transmit electrodes (e.g., seventh to tenth transmit electrodes **TE7** to **TE10**) located in the second area **AR1-2**.

Alternatively, the first and second areas **AR1-1** and **AR1-2** may be defined in the sensing area **200A** based on the plurality of receive electrodes **RE1** to **RE10**. For example, an area which is overlapped with the fourth receive electrode **RE4** overlapped with the first coordinates **CP1** and is overlapped with the three and fifth receive electrodes **RE3** and **RE5** adjacent to the fourth receive electrode **RE4** may be defined as a first area, and an area overlapped with the remaining receive electrodes (e.g., the first, second, and sixth receive electrodes **RE1**, **RE2**, and **RE6**) may be defined as a second area.

Referring to FIGS. **10B**, the second uplink signal **ULS2** may be provided to transmit electrodes (e.g., the first to sixth transmit electrodes **TE1** to **TE6**) located in the first area **AR1-1** during an even-numbered first driving frame **NDF2** of the first driving mode **NM**. The first uplink signal **ULS1** may be provided to transmit electrodes (e.g., the seventh to tenth transmit electrodes **TE7** to **TE10**) located in the second area **AR1-2**.

Referring to FIGS. **10C**, when the input device **2000** is located at a second position, the input sensor **200** may sense second coordinates **CP2** corresponding to the second position. The sensor controller **200C** may define the first area **AR2-1** and **AR2-2** based on the second coordinates **CP2**. The first area **AR2-1** may be a portion of the sensing area **200A** overlapped with the second coordinates **CP2**, and the second area **AR2-2** may be the rest of the sensing area **200A** except for the first area **AR2-1**.

In an odd-numbered first driving frame **NDF1** of the first driving mode **NM**, the first uplink signal **ULS1** may be provided to transmit electrodes (e.g., the fifth to tenth transmit electrodes **TE5** to **TE10**) located in the first area **AR2-1**. The second uplink signal **ULS2** may be provided to transmit electrodes (e.g., first to fourth transmit electrodes **TE1** to **TE4**) located in the second area **AR2-2**.

Referring to FIGS. **10D**, the second uplink signal **ULS2** may be provided to transmit electrodes (e.g., fifth to tenth transmit electrodes **TE5** to **TE10**) located in the first area **AR2-1** during an even-numbered first driving frame **NDF2** of the first driving mode **NM**. The first uplink signal **ULS1** may be provided to transmit electrodes (e.g., the first to fourth transmit electrodes **TE1** to **TE4**) located in the second area **AR2-2**.

The first area **AR1-1** or **AR2-1** and the second area **AR1-2** or **AR2-2** may differ in area from each other in the first driving mode **NM**. As shown in FIG. **13A**, an intensity **SS1** of the first uplink signal **ULS1** and an intensity **SS2** of the second uplink signal **ULS2** may be different from each other. The case where the intensity **SS2** of the second uplink signal **ULS2** is greater than the intensity **SS1** of the first uplink signal **ULS1** is illustrated as an example in FIG. **13A**. However, the intensity **SS2** of the second uplink signal **ULS2** and the intensity **SS1** of the first uplink signal **ULS1** according to some embodiments of the present disclosure are not limited thereto. For example, the intensity **SS2** of the second uplink signal **ULS2** may be less than the intensity **SS1** of the first uplink signal **ULS1**. Alternatively, the

intensity **SS2** of the second uplink signal **ULS2** may be the same as the intensity **SS1** of the first uplink signal **ULS1**.

The sensor controller **200C** may control areas of the first area **AR1-1** and **AR2-1** and the second areas **AR1-2** and **AR2-2** and intensities **SS1** and **SS2** of the first and second uplink signals **ULS1** and **ULS2**, thus controlling a degree to which ripples generated at the potential of a second electrode **CE** (refer to FIG. **5**) by the first and second uplink signals **ULS1** and **ULS2** are offset with each other.

When viewed from the two first driving frames **NDF1** and **NDF2**, the first and second uplink signals **ULS1** and **ULS2**, each of which has an inverted phase, may be provided to the first area **AR1-1** and the second and first uplink signals **ULS2** and **ULS1**, each of which has an inverted phase, may be provided to the second area **AR1-2**. Thus, although a ripple is generated at the potential of a second electrode **CE** due to parasitic capacitance **Cb** (refer to FIG. **5**) between the input sensor **200** and the second electrode **CE**, when viewed from the two first driving frames **NDF1** and **NDF2**, an effect in which the ripple is offset may occur. Thus, a flicker due to the parasitic capacitance **Cb** may be removed. As a result, display quality of the display panel **100** may be relatively improved in the first driving mode **NM**.

Hereinafter, a scheme where the first and second uplink signals **ULS1** and **ULS2** are alternately applied to the first area **AR1-1** in units of two first driving frames **NDF1** and **NDF2** and where the second and first uplink signals **ULS2** and **ULS1** are alternately applied to the second area **AR1-2** may be referred to as a first charge cancellation scheme.

Referring to FIGS. **9B**, **11A**, and **11B**, when the display panel **100** operates the first driving mode **NM**, the sensor controller **200C** (refer to FIG. **8**) may transmit an uplink signal **ULS** to the input sensor **200**. Hereinafter, for convenience of description, an interval overlapped with odd-numbered first driving frames **NDF1** and **NDF3** in a first interval **PU1** (refer to FIG. **7**) where the uplink signal **ULS** is transmitted may be referred to as a first sub-interval **PUa**, and an interval overlapped with an even-numbered first driving frames **NDF2** and **NDF4** may be referred to as a second sub-interval **PUB**.

The phase of the uplink signal **ULS** in the first sub-interval **PUa** may be inverted from the phase of the uplink signal **ULS** in the second sub-interval **PUB**. In other words, the phase of the uplink signal **ULS** may be inverted in units of one first driving frame **NDF1** to **NDF4**. The uplink signal **ULS** applied to the input sensor **200** during the odd-numbered first driving frames **NDF1** and **NDF3** may have a phase delayed by 180° with the uplink signal **ULS** applied to the input sensor **200** during the even-numbered first driving frames **NDF2** and **NDF4**. The sensor controller **200C** may output an uplink signal **ULS** having a positive phase during the first sub-interval **PUa** and may output an uplink signal **ULS** having a reverse phase or a negative phase during the second sub-interval **PUB**. The first and second sub-intervals **PUa** and **PUB** may be alternately arranged.

When the sensor controller **200C** applies one uplink signal **ULS** to the input sensor **200**, the sensing area **200A** may fail to be divided into first and second areas.

As shown in FIG. **11A**, in the odd-numbered first driving frame **NDF1** of the first driving mode **NM**, the uplink signal **ULS** having the positive phase may be provided to all transmit electrodes (e.g., first to tenth transmit electrodes **TE1** to **TE10**) located in the sensing area **200A**. As shown in FIG. **11B**, the uplink signal **ULS** having the reverse phase or the negative phase may be provided to all the transmit electrodes (e.g., the first to tenth transmit electrodes **TE1** to

TE10) located in the sensing area 200A during the even-numbered first driving frame NDF2 of the first driving mode NM.

When viewed from the two first driving frames NDF1 and NDF2, an uplink signal ULS having an inverted phase may be provided to the sensing area 200A. Thus, although a ripple is generated at the potential of the second electrode CE (refer to FIG. 5) due to the parasitic capacitance Cb (refer to FIG. 5) between the input sensor 200 and the second electrode CE, when viewed from the two first driving frames NDF1 and NDF2, an effect in which the ripple is offset may occur. Thus, a flicker due to the parasitic capacitance Cb may be removed. As a result, display quality of the display panel 100 may be relatively improved in the first driving mode NM.

Hereinafter, a scheme where the uplink signal ULS with the positive phase and the reverse phase or the negative phase is applied to the sensing area 200A in units of the two first driving frames NDF1 and NDF2 may be referred to as a temporal averaging scheme.

Because a period where the write frame SF1 is generated increases when the first driving mode NM switches to the second driving mode LM, it is difficult to offset a ripple generated at the potential of the second electrode CE by adopting the first charge cancellation scheme and the temporal averaging scheme. Thus, according to some embodiments of the present disclosure, a ripple generated at the potential of the second electrode CE may be offset in a scheme (e.g., a second charge cancellation scheme) different from the first charge cancellation scheme and the temporal averaging scheme in the second driving mode LM.

Referring to FIGS. 9A, 9B, and 12, when the display panel 100 operates in the second driving mode LM, the sensor controller 200C (refer to FIG. 8) may transmit a second mode uplink signal (e.g., a third uplink signal ULS3 and a fourth uplink signal ULS4) to the input sensor 200 during the write frame SF1. An interval corresponding to the first interval PU1 where the third and fourth uplink signals ULS3 and ULS4 are transmitted may be included in the write frame SF1. The state where the input sensor 200 operates in the first mode MD1 (refer to FIG. 7) is illustrated as an example in FIGS. 9A and 9B. However, even when the input sensor 200 operates in a second mode MD2 (refer to FIG. 7), the third and fourth uplink signals ULS3 and ULS4 may be transmitted to the input sensor 200 during a first interval PU2 (refer to FIG. 7).

The fourth uplink signal ULS4 may have a phase inverted from the third uplink signal ULS3 in the first interval PU1. According to some embodiments of the present disclosure, the fourth uplink signal ULS4 may be a signal, a phase of which is more delayed by 180° than the third uplink signal ULS3. When the third uplink signal ULS3 has positive polarity (+) in a portion of the first interval PU1, the fourth uplink signal ULS4 may have negative polarity (-). When the third uplink signal ULS3 has negative polarity (-) in another portion of the first interval PU1, the fourth uplink signal ULS4 may have positive polarity (+).

The sensing area 200A of the input sensor 200 may be divided into the third and fourth areas AR3-1 and AR3-2 during the write frame SF1 of the second driving mode LM.

When the input device 2000 is located at a third position, the input sensor 200 may sense third coordinates CP3 corresponding to the third position. The sensor controller 200C may define the third area AR3-1 based on the third coordinates CP3. The third area AR3-1 may be overlapped with the third coordinates CP3. The third area AR3-1 may be a portion of the sensing area 200A, and the fourth area

AR3-2 may be the rest of the sensing area 200A except for the third area AR3-1. The third and fourth areas AR3-1 and AR3-2 may be defined based on the plurality of transmit electrodes TE1 to TE10. The third uplink signal ULS3 may be provided to transmit electrodes (e.g., the first to fifth transmit electrodes TE1 to TE5) located in the third area AR3-1. The fourth uplink signal ULS4 may be provided to transmit electrodes (e.g., the sixth to tenth transmit electrodes TE6 to TE10) located in the fourth area AR3-2.

The third area AR3-1 and the fourth area AR3-2 may be the same in area as each other in the second driving mode LM. The third area AR3-1 and the fourth area AR3-2 in the second driving mode may differ in area from the first areas AR1-1 and AR2-1 and the second areas AR1-2 and AR2-2 in the first driving mode NM. As shown in FIG. 13B, an intensity SS3 of the third uplink signal ULS3 and an intensity SS4 of the fourth uplink signal ULS4 may be the same as each other. The third and fourth uplink signals ULS3 and ULS4, each of which has an inverted phase, may be applied to the third and fourth areas AR3-1 and AR3-2, respectively. When an area between the third area AR3-1 and the fourth area AR3-2 is balanced in the second driving mode LM and when an intensity between the third and fourth uplink signals ULS3 and ULS4 is balanced, a ripple may be offset in one write frame SF1.

Thus, although a ripple is generated at the potential of the second electrode CE (refer to FIG. 5) due to the parasitic capacitance Cb (refer to FIG. 5) between the input sensor 200 and the second electrode CE, an effect in which the ripple is offset may occur in the one write frame SF1. Thus, a flicker due to the parasitic capacitance Cb may be removed. As a result, display quality of the display panel 100 may be relatively improved in the second driving mode LM.

According to some embodiments of the present disclosure, unlike the first charge cancellation scheme and the temporal averaging scheme, which may remove the ripple on the basis of the two first driving frames, the scheme (i.e., the second charge cancellation scheme) capable of removing the ripple in the one write frame SF1 in the second driving mode LM may be adopted. In other words, when the ripple generated at the potential of the second electrode CE is removed after the two first driving frames NDF1 and NDF2 elapse in the first charge cancellation scheme and the temporal averaging scheme adopted in the first driving mode NM, whereas the ripple generated at the potential of the second electrode CE may be removed in the one write frame SF1 in the second charge cancellation scheme.

Thus, although the operating frequency of the display panel 100 is low in the second driving mode LM, a ripple offset scheme may be changed and applied to the input sensor 200, thus stably removing a flicker phenomenon due to the uplink signals ULS3 and ULS4 in the second driving mode LM. As a result, display quality may be relatively improved.

Meanwhile, the sensor controller 200C may apply a fifth uplink signal ULS5 to the input sensor 200 in response to each of holding frames SF2 during the second driving mode LM. The fifth uplink signal ULS5 may be a normal uplink signal to which the temporal averaging scheme, the first and second charge cancellation schemes, and the like are not applied. In other words, the normal uplink signal may be generated to have the same phase for each holding frame SF2. The data driver 100C3 (refer to FIG. 6) may output a bias data signal Vdc having a certain potential at a black gray scale or a low gray scale in each holding frame SF2. Furthermore, the scan driver 100C2 (refer to FIG. 6) may be maintained in an inactive state in the holding frame SF2.

Thus, when the fifth uplink signal ULS5 is applied to the input sensor 200 in the holding frame SF2, although a ripple is generated at the potential of the second electrode CE, a flicker may fail to be viewed on an image displayed on the display panel 100 (refer to FIG. 6). Thus, the ripple offset scheme such as the temporal averaging scheme and the first and second charge cancellation schemes may fail to be applied in the holding frame SF2.

FIG. 14A is a waveform diagram illustrating a scan control signal, a light emitting control signal, and first and second uplink signals according to some embodiments of the present disclosure. FIG. 14B is a waveform diagram illustrating a scan control signal, a light emitting control signal, and an uplink signal according to some embodiments of the present disclosure. FIG. 15A is a plan view illustrating an operation of an input sensor in a first write frame shown in FIG. 14A. FIG. 15B is a plan view illustrating an operation of an input sensor in a second write frame shown in FIG. 14A. FIG. 15C is a plan view illustrating an operation of an input sensor in a first write frame shown in FIG. 14B. FIG. 15D is a plan view illustrating an operation of an input sensor in a second write frame shown in FIG. 14B.

Operations of a display panel 100 (refer to FIG. 6) and an input sensor 200 in a first driving mode NM in FIGS. 14A and 14B are duplicated with the contents described with reference to FIGS. 9A and 9B. Thus, a description of a detailed operation in the first driving mode NM will be omitted.

Referring to FIGS. 3, 6, and 14A, each of a plurality of second driving frames LDF1 and LDF2 may include k write frames and j holding frames. According to some embodiments of the present disclosure, k may be an even number of two or more and j may be a number greater than k. The case where two write frames (e.g., a first write frame SF1a and a second write frame SF1b) are included is illustrated according to some embodiments of the present disclosure in FIG. 14A, but the number of write frames is not limited thereto. Furthermore, the case where four holding frames SF2 are included is illustrated according to some embodiments of the present disclosure in FIG. 14A, but the number of holding frames is not limited thereto. The number of write frames and the number holding frames may vary with a second operating frequency. For example, the lower the second operating frequency, the more the number of k and the number of j may increase.

A data driver 100C3 (refer to FIG. 6) may apply a data signal Vdata (e.g., may be referred to as a "normal data signal" or a "valid data signal") including image information to the display panel 100 in each of the first and second write frames SF1a and SF1b. The data driver 100C3 may apply a data signal Vdc (e.g., may be referred to as a "black data signal" or a "bias data signal"), which does not include image information, to the display panel 100 during each holding frame SF2. The bias data signal Vdc may be a data signal having a black gray scale or a low gray scale.

In the second driving mode LM, a scan driver 100C2 (refer to FIG. 6) may be activated during k write frames and may be deactivated during j holding frames. A light emitting driver 100C4 (refer to FIG. 6) may be activated during the k write frames and the j holding frames. A scan control signal CONT1 provided to the scan driver 100C2 may include a scan start signal FLM and a scan clock signal CLK. A light emitting control signal CONT3 provided to the light emitting driver 100C4 may include a light emitting start signal E_FLM and a light emitting clock signal E_CLK.

The scan start signal FLM and the scan clock signal CLK may be activated in each of the first and second write frames

SF1a and SF1b. Thus, the scan driver 100C2 is activated in only one write frame SF1 in the embodiments shown in FIG. 9A, whereas the scan driver 100C2 may be activated during two write frames SF1a and SF1b in the embodiments shown in FIG. 14A. According to some embodiments of the present disclosure, the scan driver 100C2 may be deactivated during each holding frame SF2. Meanwhile, the light emitting driver 100C4 may be activated in the first and second write frames SF1a and SF1b and may also be activated during each holding frame SF2. Thus, an image including image information may be displayed in the first and second write frames SF1a and SF1b, and a new image may not be displayed on the display panel 100 as the scan driver 100C2 is deactivated in the holding frame SF2 and the image may be maintained.

Referring to FIGS. 14A, 15A, and 15B, when the display panel 100 operates in the second driving mode LM, a sensor controller 200C (refer to FIG. 8) may transmit a first uplink signal ULS1 and a second uplink signal ULS2 to an input sensor 200 during the first write frame SF1a. An interval corresponding to a first interval PU1 where the first and second uplink signals ULS1 and ULS2 are transmitted may be included in the first write frame SF1a. The first and second uplink signals ULS1 and ULS2 may be the same as signals provided to the input sensor 200 in the first driving mode NM.

Thus, the first and second uplink signals ULS1 and ULS2 may have inverted phases in the first interval PU1. For example, the second uplink signal ULS2 may be a signal, a phase of which is delayed by 180° from the first uplink signal ULS1.

A sensing area 200A of the input sensor 200 may include first and second areas AR1-1 and AR1-2 in the first write frame SF1a of the second driving mode LM. The first uplink signal ULS1 may be provided to transmit electrodes (e.g., first to sixth transmit electrodes TE1 to TE6) located in the first area AR1-1. The second uplink signal ULS2 may be provided to transmit electrodes (e.g., seventh to tenth transmit electrodes TE7 to TE10) located in the second area AR1-2.

Meanwhile, the second uplink signal ULS2 may be provided to transmit electrodes (e.g., the first to sixth transmit electrodes TE1 to TE6) located in the first area AR1-1 in the second write frame SF1b of the second driving mode LM. The first uplink signal ULS1 may be provided to transmit electrodes (e.g., the seventh to tenth transmit electrodes TE7 to TE10) located in the second area AR1-2.

The first area AR1-1 and the second area AR1-2 may differ in area from each other in the second driving mode LM. An intensity SS1 of the first uplink signal ULS1 and an intensity SS2 of the second uplink signal ULS2 may be the same as or different from each other.

Each of the driving frames LDF1 and LDF2 of the second driving mode LM may include an even number of write frames, for example, the two write frames SF1a and SF1b. When viewed from the two write frames SF1a and SF1b, the first and second uplink signals ULS1 and ULS2, each of which has an inverted phase, may be provided to the first area AR1-1 and the second and first uplink signals ULS2 and ULS1, each of which has an inverted phase, may be provided to the second area AR1-2. Thus, although a ripple is generated at the potential of a second electrode CE (refer to FIG. 5) due to parasitic capacitance Cb (refer to FIG. 5) between the input sensor 200 and the second electrode CE, when viewed from the two write frames SF1a and SF1b, an effect in which the ripple is offset may occur.

When the ripple generated at the potential of the second electrode CE is offset in a first charge cancellation scheme in the first driving mode NM, a ripple generated at the potential of the second electrode CE may also be offset in the first charge cancellation scheme in the second driving mode LM. In other words, when an even number of write frames are provided although the first driving mode NM switches to the second driving mode LM, the ripple generated at the potential of the second electrode CE may be offset by applying the same scheme as the first driving mode NM.

Thus, although the operating frequency of the display panel **100** (refer to FIG. **6**) changes, the ripple generated at the potential of the second electrode CE may be offset in the same scheme. As a result, a flicker due to parasitic capacitance C_b may be removed in the second driving mode LM and display quality of the display panel **100** may be relatively improved.

Referring to FIGS. **14B**, **15C**, and **15D**, when the display panel **100** operates in the second driving mode LM, the sensor controller **200C** may transmit the same uplink signal ULS as that in the first driving mode NM to the input sensor **200** during each of the second driving frames LDF1 and LDF2. Hereinafter, for convenience of description, an interval overlapped with odd-numbered first driving frames NDF1 and NDF3 and the first write frame SF1a in a first interval PU1 (refer to FIG. **7**) where the uplink signal ULS is transmitted may be referred to as a first sub-interval PUA, and an interval overlapped with an even-numbered first driving frames NDF2 and NDF4 and the second write frame SF1b may be referred to as a second sub-interval PUB.

The phase of the uplink signal ULS in the first sub-interval PUA may be inverted from the phase of the uplink signal ULS in the second sub-interval PUB. In other words, the phase of the uplink signal ULS may be inverted in units of one first driving frame NDF1, NDF2, NDF3, or NDF4 in the first driving mode NM. The phase of the uplink signal ULS may be inverted in units of one write frame SF1a or SF1b or in units of one holding frame SF2 in the second driving mode LM. For example, the uplink signal ULS applied to the input sensor **200** during the first write frame SF1a may have a phase delayed by 180° with the uplink signal ULS applied to the input sensor **200** during the second write frame SF1b. The sensor controller **200C** may output an uplink signal ULS having a positive phase during the first sub-interval PUA and may output an uplink signal ULS having a reverse phase or a negative phase during the second sub-interval PUB. The first and second sub-intervals PUA and PUB may be alternately arranged.

When the sensor controller **200C** applies one uplink signal ULS to the input sensor **200**, the sensing area **200A** may fail to be divided into first and second areas.

As shown in FIG. **15C**, in the first write frame SF1a of the second driving mode LM, the uplink signal ULS having the positive phase may be provided to all transmit electrodes (e.g., first to tenth transmit electrodes TE1 to TE10) located in the sensing area **200A**. As shown in FIG. **15D**, in the second write frame SF1b of the second driving mode LM, the uplink signal ULS having the reverse phase or the negative phase may be provided to all transmit electrodes (e.g., the first to tenth transmit electrodes TE1 to TE10) located in the sensing area **200A**.

When viewed from the two write frames SF1a and SF1b, an uplink signal ULS having an inverted phase may be provided to the sensing area **200A**. Thus, although a ripple is generated at the potential of the second electrode CE (refer to FIG. **5**) due to parasitic capacitance C_b (refer to FIG. **5**) between the input sensor **200** and the second electrode CE,

when viewed from the two write frames SF1a and SF1b, an effect in which the ripple is offset may occur. Thus, a flicker due to the parasitic capacitance C_b may be removed. As a result, display quality of the display panel **100** may be relatively improved in the second driving mode LM.

When the ripple generated at the potential of the second electrode CE is offset in a temporal averaging scheme in the first driving mode NM, a ripple generated at the potential of the second electrode CE may also be offset in the temporal averaging scheme in the second driving mode LM. In other words, when an even number of write frames are provided although the first driving mode NM switches to the second driving mode LM, the ripple generated at the potential of the second electrode CE may be offset by applying the same scheme as the first driving mode NM.

Thus, although the operating frequency of the display panel **100** changes, the ripple generated at the potential of the second electrode CE may be offset in the same scheme. As a result, a flicker due to parasitic capacitance C_b may be removed in the second driving mode LM and display quality of the display panel **100** may be relatively improved.

FIG. **16A** is a waveform diagram illustrating a scan control signal, a light emitting control signal, and first and second uplink signals according to some embodiments of the present disclosure. FIG. **16B** is a waveform diagram illustrating a scan control signal, a light emitting control signal, and an uplink signal according to some embodiments of the present disclosure.

Operations of a display panel **100** (refer to FIG. **6**) and an input sensor **200** in a first driving mode NM in FIGS. **16A** and **16B** are duplicated with the contents described with reference to FIGS. **9A** and **9B**. Thus, a description of a detailed operation in the first driving mode NM will be omitted.

Referring to FIGS. **3**, **6**, and **16A**, each of a plurality of second driving frames LDF1 and LDF2 may include a first sub-frame SFA and a plurality of second sub-frames SFB. The case where the second driving frame LDF1 includes five second sub-frames SFB is illustrated according to some embodiments of the present disclosure in FIG. **16A**, but the number of second sub-frames SFB is not limited thereto, which may vary with a second operating frequency.

A data driver **100C3** (refer to FIG. **6**) may apply a data signal Vdata (e.g., may be referred to as a "normal data signal" or a "valid data signal") including image information to the display panel **100** in the first sub-frame SFA. The data driver **100C3** may apply a data signal Vdc (e.g., may be referred to as a "black data signal" or a "bias data signal"), which does not include image information, to the display panel **100** during each second sub-frame SFB. The bias data signal Vdc may be a data signal having a black gray scale or a low gray scale.

In the second driving mode LM, the scan driver **100C2** (refer to FIG. **6**) may be activated as a whole during the first sub-frame SFA and may be partially activated during each second sub-frame SFB. A scan control signal CONT1 provided to a scan driver **100C2** may include a scan start signal FLM and a scan clock signal CLK. The scan clock signal CLK may be activated as a whole in the first sub-frame SFA. Each second sub-frame SFB may include an active interval P1 and an inactive interval P2. The active interval P1 may be referred to as an interval where the scan clock signal CLK is activated. The inactive interval P2 may be referred to as an interval where the scan clock signal CLK is deactivated.

A light emitting driver **100C4** (refer to FIG. **6**) may be activated as a whole during the first sub-frame SFA and the second sub-frame SFB. A light emitting control signal

CONT3 provided to the light emitting driver 100C4 (refer to FIG. 6) may include a light emitting start signal E_FLM and a light emitting clock signal E_CLK. The light emitting driver 100C4 may be activated as a whole during the first sub-frame SFa and each second sub-frame SFb in the second driving mode LM.

Thus, an image corresponding to a bias data signal Vdc may be displayed on the display panel 100 as the scan driver 100C2 is activated in the active interval P1 of each second sub-frame SFb.

When the display panel 100 operates in the second driving mode LM, the sensor controller 200C may transmit a first uplink signal ULS1 and a second uplink signal ULS2 to the input sensor 200. An interval corresponding to a first interval PU1 where the first and second uplink signals ULS1 and ULS2 are transmitted may be included in the first sub-frame SFa. The first and second uplink signals ULS1 and ULS2 may be the same as signals provided to the input sensor 200 in the first driving mode NM.

Thus, the first and second uplink signals ULS1 and ULS2 may have inverted phases in the first interval PU1. For example, the second uplink signal ULS2 may be a signal, a phase of which is delayed by 180° from the first uplink signal ULS1.

A sensing area 200A of the input sensor 200 may include first and second areas AR1-1 and AR1-2 in the first sub-frame SFa of the second driving mode LM. The first uplink signal ULS1 may be provided to transmit electrodes (e.g., first to sixth transmit electrodes TE1 to TE6, refer to FIG. 15A) located in the first area AR1-1. The second uplink signal ULS2 may be provided to transmit electrodes (e.g., seventh to tenth transmit electrodes TE7 to TE10, refer to FIG. 15A) located in the second area AR1-2.

Meanwhile, the active interval P1 of each second sub-frame SFb of the second driving mode LM may be overlapped with the first interval PU1 and the inactive interval P2 may not be overlapped with the first interval PU1. In the active interval P1 of the first second sub-frame SFb of the second driving mode LM, the second uplink signal ULS2 may be provided to transmit electrodes (e.g., the first to sixth transmit electrodes TE1 to TE6, refer to FIG. 15B) located in the first area AR1-1. The first uplink signal ULS1 may be provided to transmit electrodes (e.g., the seventh to tenth transmit electrodes TE7 to TE10, refer to FIG. 15B) located in the second area AR1-2.

The first area AR1-1 and the second area AR1-2 may differ in area from each other in the second driving mode LM. An intensity of the first uplink signal ULS1 and an intensity of the second uplink signal ULS2 may be the same as or different from each other.

Each of the second driving frames LDF1 and LDF2 of the second driving mode LM may include an even number of sub-frames. When viewed from the two consecutive sub-frames SFa and SFb, the first and second uplink signals ULS1 and ULS2, each of which has an inverted phase, may be provided to the first area AR1-1 and the second and first uplink signals ULS2 and ULS1, each of which has an inverted phase, may be provided to the second area AR1-2. Thus, although a ripple is generated at the potential of the second electrode CE (refer to FIG. 5) due to parasitic capacitance Cb (refer to FIG. 5) between the input sensor 200 and the second electrode CE, when viewed from the two consecutive sub-frames SFa and SFb, an effect in which the ripple is offset may occur.

When the ripple generated at the potential of the second electrode CE is offset in a first charge cancellation scheme in the first driving mode NM, a ripple generated at the

potential of the second electrode CE may also be offset in the first charge cancellation scheme in the second driving mode LM. In other words, as an active interval of each holding frame is included although the first driving mode NM switches to the second driving mode LM, the ripple generated at the potential of the second electrode CE may be offset by applying the same scheme as the first driving mode NM.

Thus, although the operating frequency of the display panel 100 changes, the ripple generated at the potential of the second electrode CE may be offset in the same scheme. As a result, a flicker due to parasitic capacitance Cb may be removed in the second driving mode LM and display quality of the display panel 100 may be relatively improved.

Referring to FIGS. 16b, 15C, and 15D, when the display panel 100 operates in the second driving mode LM, the sensor controller 200C may transmit the same uplink signal ULS as that in the first driving mode NM to the input sensor 200 during each of the second driving frames LDF1 and LDF2. Hereinafter, for convenience of description, an interval overlapped with odd-numbered first driving frames NDF1 and NDF3, the first sub-frame SFa, an odd-numbered second frame SFb in a first interval PU1 (refer to FIG. 7) where the uplink signal ULS is transmitted may be referred to as a first sub-interval PUa, and an interval overlapped with an even-numbered first driving frames NDF2 and NDF4 and the even-numbered second sub-frame SFb may be referred to as a second sub-interval PUB.

The phase of the uplink signal ULS in the first sub-interval PUa may be inverted from the phase of the uplink signal ULS in the second sub-interval PUB. In other words, the phase of the uplink signal ULS may be inverted in units of one first driving frame NDF1, NDF2, NDF3, or NDF4 in the first driving mode NM. The phase of the uplink signal ULS may be inverted in units of one sub-frame SFa or SFb in the second driving mode LM. Each second sub-frame SFb may include an active interval P1 and an inactive interval P2. The active interval P1 of each second sub-frame SFb may correspond to the first or second sub-interval PUa or PUB. For example, an active interval P1 of an odd-numbered second sub-frame SFb among the plurality of second sub-frames SFb may correspond to the second sub-interval PUB, and an active interval P1 of an even-numbered second sub-frame SFb may correspond to the first sub-interval PUa.

For example, the uplink signal ULS applied to the input sensor 200 during the first sub-frame SFa may have a phase delayed by 180° with the uplink signal ULS applied to the input sensor 200 during the first second sub-frame SFb. The sensor controller 200C may output an uplink signal ULS having a positive phase during the first sub-frame SFa and may output an uplink signal ULS having a reverse phase or a negative phase during an active interval P1 of the first second sub-frame SFb. The first and second sub-intervals PUa and PUB may be alternately arranged.

When the sensor controller 200C applies one uplink signal ULS to the input sensor 200, the sensing area 200A may fail to be divided into first and second areas.

In the first sub-frame SFa of the second driving mode LM, the uplink signal ULS having the positive phase may be provided to all transmit electrodes (e.g., first to tenth transmit electrodes TE1 to TE10, refer to FIG. 15C) located in the sensing area 200A. The uplink signal ULS having the reverse phase or the negative phase may be provided to all the transmit electrodes (e.g., the first to tenth transmit electrodes TE1 to TE10, refer to FIG. 15D) located in the sensing area 200A during the active interval P1 of the first second sub-frame SFb of the second driving mode SF.

When viewed from the two sub-frames SFa and SFb, an uplink signal ULS having an inverted phase may be provided to the sensing area 200A. Thus, although a ripple is generated at the potential of the second electrode CE (refer to FIG. 5) due to parasitic capacitance Cb (refer to FIG. 5) between the input sensor 200 and the second electrode CE, when viewed from the two sub-frames SFa and SFb, an effect in which the ripple is offset may occur. Thus, a flicker due to the parasitic capacitance Cb may be removed. As a result, display quality of the display panel 100 may be relatively improved in the second driving mode LM.

When the ripple generated at the potential of the second electrode CE is offset in a temporal averaging scheme in the first driving mode NM, a ripple generated at the potential of the second electrode CE may also be offset in the temporal averaging scheme in the second driving mode LM. In other words, when an even number of write frames are provided although the first driving mode NM switches to the second driving mode LM, the ripple generated at the potential of the second electrode CE may be offset by applying the same scheme as the first driving mode NM.

Thus, although the operating frequency of the display panel 100 changes, the ripple generated at the potential of the second electrode CE may be offset in the same scheme. As a result, a flicker due to parasitic capacitance Cb may be removed in the second driving mode LM and display quality of the display panel 100 may be relatively improved.

FIG. 17A is a waveform diagram illustrating a scan control signal, a light emitting control signal, and first and second uplink signals according to some embodiments of the present disclosure. FIG. 17B is a waveform diagram illustrating a scan control signal, a light emitting control signal, and an uplink signal according to some embodiments of the present disclosure.

Operations of a display panel 100 (refer to FIG. 6) and an input sensor 200 in a first driving mode NM in FIGS. 17A and 17B are duplicated with the contents described with reference to FIGS. 9A and 9B. Thus, a description of a detailed operation in the first driving mode NM will be omitted.

Referring to FIGS. 3, 6, and 17A, each of a plurality of second driving frames LDF1 and LDF2 may include a first sub-frame SFa and a plurality of second sub-frames O-SFb and E SFb.

In the second driving mode LM, a scan driver 100C2 may be activated as a whole during the first sub-frame SFa and may be partially activated during each of the second sub-frames O-SFb and E-SFb. A scan control signal CONT1 provided to the scan driver 100C2 may include a scan start signal FLM and a scan clock signal CLK. The scan clock signal CLK may be activated as a whole in the first sub-frame SFa. An odd-numbered second sub-frame O-SFb among the plurality of second sub-frames O-SFb and E-SFb may include an active interval Pa and an inactive interval Pb. The active interval Pa may be referred to as an interval where the scan clock signal CLK is activated. The inactive interval Pb may be referred to as an interval where the scan clock signal CLK is deactivated.

A light emitting driver 100C4 may be activated as a whole during the first sub-frame SFa and each of the second sub-frames O-SFb and E-SFb. A light emitting control signal CONT3 provided to the light emitting driver 100C4 may include a light emitting start signal E_FLM and a light emitting clock signal E_CLK. The light emitting driver 100C4 may be activated as a whole during the first sub-frame SFa and each of the second sub-frames O-SFb and E-SFb in the second driving mode LM.

Thus, an image corresponding to a bias data signal Vdc may be displayed on the display panel 100 as the scan driver 100C2 is activated in the active interval Pa of an odd-numbered second sub-frame O-SFb.

When the display panel 100 operates in the second driving mode LM, a sensor controller 200C may transmit a first uplink signal ULS1 and a second uplink signal ULS2 to the input sensor 200. An interval corresponding to a first interval PU1 where the first and second uplink signals ULS1 and ULS2 are transmitted may be included in the first sub-frame SFa. The first and second uplink signals ULS1 and ULS2 may be the same as signals provided to the input sensor 200 in the first driving mode NM.

The first and second uplink signals ULS1 and ULS2 may have inverted phases in the first interval PU1. For example, the second uplink signal ULS2 may be a signal, a phase of which is delayed by 180° from the first uplink signal ULS1.

A sensing area 200A of the input sensor 200 may include first and second areas AR1-1 and AR1-2 in the first sub-frame SFa of the second driving mode LM. The first uplink signal ULS1 may be provided to transmit electrodes (e.g., first to sixth transmit electrodes TE1 to TE6, refer to FIG. 15A) located in the first area AR1-1. The second uplink signal ULS2 may be provided to transmit electrodes (e.g., seventh to tenth transmit electrodes TE7 to TE10, refer to FIG. 15A) located in the second area AR2-1.

Meanwhile, the active interval Pa of an odd-numbered second sub-frame O-SFb of the second driving mode LM may be overlapped with the first interval PU1 and the inactive interval Pb may not be overlapped with the first interval PU1. In the active interval Pa of an odd-numbered second sub-frame O-SFb of the second driving mode LM, the second uplink signal ULS2 may be provided to transmit electrodes (e.g., the first to sixth transmit electrodes TE1 to TE6, refer to FIG. 15B) located in the first area AR1-1. The first uplink signal ULS1 may be provided to transmit electrodes (e.g., the seventh to tenth transmit electrodes TE7 to TE10, refer to FIG. 15B) located in the second area AR2-1.

The first area AR1-1 and the second area AR1-2 may differ in area from each other in the second driving mode LM. An intensity of the first uplink signal ULS1 and an intensity of the second uplink signal ULS2 may be the same as or different from each other.

When viewed from the two consecutive sub-frames SFa and O-SFb, the first and second uplink signals ULS1 and ULS1, each of which has an inverted phase, may be provided to the first area AR1-1 and the second and first uplink signals ULS2 and ULS1, each of which has an inverted phase, may be provided to the second area AR1-2. Thus, although a ripple is generated at the potential of the second electrode CE (refer to FIG. 5) due to parasitic capacitance Cb (refer to FIG. 5) between the input sensor 200 and the second electrode CE, when viewed from the two consecutive sub-frames SFa and O-SFb, an effect in which the ripple is offset may occur.

When the ripple generated at the potential of the second electrode CE is offset in a first charge cancellation scheme in the first driving mode NM, a ripple generated at the potential of the second electrode CE may also be offset in the first charge cancellation scheme in the second driving mode LM. In other words, as the scan driver 100C2 is activated during the active interval Pa of an odd-numbered second sub-frame O-SFb although the first driving mode LM switches to the second driving mode LM, the ripple generated at the potential of the second electrode CE may be offset by applying the same scheme as the first driving mode NM.

Thus, although the operating frequency of the display panel **100** changes, the ripple generated at the potential of the second electrode CE may be offset in the same scheme. As a result, a flicker due to parasitic capacitance C_b may be removed in the second driving mode LM and display quality of the display panel **100** may be relatively improved.

Referring to FIG. 17B, when the display panel **100** operates in the second driving mode LM, the sensor controller **200C** may transmit the same uplink signal ULS as that in the first driving mode NM to the input sensor **200** during each of the second driving frames LDF1 and LDF2.

Each of the plurality of second driving frames LDF1 and LDF2 may include a first sub-frame SFa and a plurality of second sub-frames O-SFb and E-SFb.

In the second driving mode LM, a scan driver **100C2** may be activated as a whole during the first sub-frame SFa and may be partially activated during each of the second sub-frames O-SFb and E-SFb. A scan control signal CONT1 provided to the scan driver **100C2** may include a scan start signal FLM and a scan clock signal CLK. The scan clock signal CLK may be activated as a whole in the first sub-frame SFa. An even-numbered second sub-frame E-SFb among the plurality of second sub-frames O-SFb and E-SFb may include an active interval Pc and an inactive interval Pd. The active interval Pc may be referred to as an interval where the scan clock signal CLK is activated. The inactive interval Pd may be referred to as an interval where the scan clock signal CLK is deactivated.

The active interval Pc of an even-numbered second sub-frame E-SFb may correspond to the first or second sub-interval PUa or PUB. For example, the uplink signal ULS applied to the input sensor **200** during the first sub-frame SFa may have a phase delayed by 180° with the uplink signal ULS applied to the input sensor **200** during the active interval Pc of the even-numbered second sub-frame E-SFb. The sensor controller **200C** may output an uplink signal ULS having a positive phase during the first sub-frame SFa and may output an uplink signal ULS having a reverse phase or a negative phase during the even-numbered second sub-frame E-SFb. The first and second sub-intervals PUa and PUB may be alternately arranged.

When the sensor controller **200C** applies one uplink signal ULS to the input sensor **200**, the sensing area **200A** may fail to be divided into first and second areas.

In the first sub-frame SFa of the second driving mode LM, the uplink signal ULS having the positive phase may be provided to all transmit electrodes (e.g., first to tenth transmit electrodes TE1 to TE10, refer to FIG. 15C) located in the sensing area **200A**. The uplink signal ULS having the reverse phase or the negative phase may be provided to all the transmit electrodes (e.g., the first to tenth transmit electrodes TE1 to TE10, refer to FIG. 15D) located in the sensing area **200A** during the active interval Pc of the even-numbered second sub-frame E-SFb of the second driving mode LM.

When viewed from the two sub-frames SFa and E-SFb, an uplink signal ULS having an inverted phase may be provided to the sensing area **200A**. Thus, although a ripple is generated at the potential of the second electrode CE (refer to FIG. 5) due to parasitic capacitance C_b (refer to FIG. 5) between the input sensor **200** and the second electrode CE, when viewed from the two sub-frames SFa and E-SFb, an effect in which the ripple is offset may occur. Thus, a flicker due to the parasitic capacitance C_b may be removed. As a result, display quality of the display panel **100** may be relatively improved in the second driving mode LM.

When the ripple generated at the potential of the second electrode CE is offset in a temporal averaging scheme in the first driving mode NM, a ripple generated at the potential of the second electrode CE may also be offset in the temporal averaging scheme in the second driving mode LM. In other words, when the scan driver **100C2** is activated during the active interval Pc of the even-numbered second sub-frame E-SFb although the first driving mode NM switches to the second driving mode LM, the ripple generated at the potential of the second electrode CE may be offset by applying the same scheme as the first driving mode NM.

Thus, although the operating frequency of the display panel **100** changes, the ripple generated at the potential of the second electrode CE may be offset in the same scheme. As a result, a flicker due to parasitic capacitance C_b may be removed in the second driving mode LM and display quality of the display panel **100** may be relatively improved.

According to some embodiments of the present disclosure, unlike a first charge cancellation scheme and a temporal averaging scheme, which remove the ripple on the basis of two first driving frames in the first driving mode, a scheme (i.e., a second charge cancellation scheme) capable of removing a ripple in one write frame in the second driving mode may be adopted. Thus, although the operating frequency of the display panel may be relatively low in the second driving mode, a ripple offset scheme may be changed and applied to the input sensor, thus stably removing a flicker phenomenon due to the uplink signal in the second driving mode. As a result, display quality may be relatively improved.

While the present disclosure has been described with reference to some embodiments thereof, it will be apparent to those of ordinary skill in the art that various changes and modifications may be made thereto without departing from the spirit and scope of the present disclosure as set forth in the following claims. Accordingly, the technical scope of the present disclosure should not be limited to the contents described in the detailed description of the specification, but should be defined by the appended claims, and their equivalents.

What is claimed is:

1. An electronic device, comprising:
 - a display panel configured to display images;
 - an input sensor on the display panel and configured to operate in a first mode to detect a first input by an input device or a second mode to detect a second input different from the first input;
 - a panel driver configured to drive the display panel at a first operating frequency in a first driving mode and to drive the display panel at a second operating frequency lower than the first operating frequency in a second driving mode; and
 - a sensor controller configured to control driving of the input sensor,
 wherein the display panel is configured to display the images in units of first driving frames in the first driving mode and displays the images in units of second driving frames in the second driving mode, and
 - wherein the sensor controller is configured to transmit a first mode uplink signal for synchronization with the input device to the input sensor in a first scheme in the first driving mode and to transmit a second mode uplink signal for synchronization with the input device to the input sensor in a second scheme different from the first scheme in the second driving mode,

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wherein the second driving frames include a write frame and a holding frame, and

wherein the sensor controller is configured to divide a sensing area into a third area and a fourth area during the write frame, to apply a third uplink signal to the third area, and to apply a fourth uplink signal having a reverse phase with the third uplink signal to the fourth area,

the sensor controller is configured to apply a fifth uplink signal to an entire sensing area during the holding frame.

2. The electronic device of claim 1, wherein the input sensor includes the sensing area and a non-sensing area adjacent to the sensing area, and

wherein the sensor controller is configured to divide the sensing area into a first area and a second area during an even-numbered first driving frame among the first driving frames, to apply a first uplink signal to the first area, to apply a second uplink signal having a reverse phase with the first uplink signal to the second area, to apply the second uplink signal to the first area during an odd-numbered first driving frame among the first driving frames, and to apply the first uplink signal to the second area.

3. The electronic device of claim 2, wherein the first area and the second area differ in area from each other.

4. The electronic device of claim 2, wherein an intensity of the first uplink signal and an intensity of the second uplink signal are different from each other.

5. The electronic device of claim 2, wherein the third area and the fourth area are a same size.

6. The electronic device of claim 5, wherein the first uplink signal has a same in intensity as the second uplink signal.

7. The electronic device of claim 2, wherein the panel driver includes:

a data driver configured to output data signals to the display panel; and

a scan driver configured to output scan signals to the display panel,

wherein the write frame is a frame where the data driver is configured to apply valid data signals to the display panel, and

wherein the holding frame is a frame where the data driver is configured to apply bias data signals to the display panel.

8. The electronic device of claim 1, wherein the input sensor includes the sensing area and a non-sensing area adjacent to the sensing area, and

wherein the sensor controller is configured to apply a first uplink signal having a positive phase to the sensing area during an odd-numbered first driving frame among the first driving frames and to apply a second uplink signal having a negative phase to the sensing area during an even-numbered first driving frame among the first driving frames.

9. The electronic device of claim 8, wherein the third area and the fourth area have a same size.

10. The electronic device of claim 9, wherein the first uplink signal has a same intensity as the second uplink signal.

11. An electronic device, comprising:

a display panel configured to display images;

an input sensor on the display panel and configured to operate in a first mode to detect a first input by an input device or a second mode to detect a second input different from the first input;

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a panel driver configured to drive the display panel at a first operating frequency in a first driving mode and to drive the display panel at a second operating frequency lower than the first operating frequency in a second driving mode; and

a sensor controller configured to control driving of the input sensor,

wherein the display panel is configured to display the images in units of first driving frames in the first driving mode and to display the images in units of second driving frames in the second driving mode,

wherein the second driving frames include k write frames and j holding frames, and

wherein the k is an even number of 2 or more and the j is a natural number,

the sensor controller is configured to apply an uplink signal having a positive phase during a first write frame among the k write frames and to apply an uplink signal having a negative phase during a second write frame among the k write frames.

12. The electronic device of claim 11, wherein the j is a number greater than the k.

13. The electronic device of claim 11, wherein the panel driver includes:

a data driver configured to output data signals to the display panel; and

a scan driver configured to output scan signals to the display panel,

wherein each of the k write frames is a frame where the data driver is configured to apply valid data signals to the display panel, and

wherein each of the j holding frames is a frame where the data driver is configured to apply bias data signals to the display panel.

14. The electronic device of claim 13, wherein the scan driver is configured to be activated during the k write frames and is configured to be deactivated during the j holding frames.

15. The electronic device of claim 11, wherein the input sensor includes a sensing area and a non-sensing area adjacent to the sensing area, and

wherein the sensor controller is configured to divide the sensing area into a first area and a second area during the first write frame among the k write frames, to apply a first uplink signal to the first area, to apply a second uplink signal having a reverse phase with the first uplink signal to the second area, and to apply the second uplink signal to the first area during the second write frame among the k write frames and applies the first uplink signal to the second area.

16. The electronic device of claim 15, wherein the first area and the second area differ in size from each other.

17. The electronic device of claim 11, wherein the input sensor includes a sensing area and a non-sensing area adjacent to the sensing area, and

wherein the sensor controller is configured to apply the uplink signal having the positive phase to the sensing area during the first write frame among the k write frames and to apply the uplink signal having the negative phase to the sensing area during the second write frame among the k write frames.

18. An electronic device, comprising:

a display panel configured to display images at a first operating frequency in a first driving mode and to display the images at a second operating frequency lower than the first operating frequency in a second driving mode;

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an input sensor on the display panel and configured to operate in a first mode to detect a first input by an input device or a second mode to detect a second input different from the first input;

a data driver configured to output data signals to the display panel;

a scan driver configured to output scan signals to the display panel; and

a sensor controller configured to control driving of the input sensor and to transmit an uplink signal for synchronization with the input device during an uplink interval,

wherein the display panel is configured to display the images in units of a first driving frame in the first driving mode and to display the images in units of a second driving frame in the second driving mode,

wherein the second driving frame includes a write frame and j holding frames, the j is a natural number, and each of the j holding frames includes an active interval where the scan driver is activated and an inactive interval where the scan driver is deactivated,

wherein the input sensor includes a sensing area and a non-sensing area adjacent to the sensing area, and

wherein the sensor controller is configured to divide the sensing area into a first area and a second area during

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an odd-numbered holding frame among the j holding frames, to apply a first uplink signal to the first area, to apply a second uplink signal having a reverse phase with the first uplink signal to the second area, and to apply the second uplink signal to the first area during an even-numbered holding frame among the j holding frames and applies the first uplink signal to the second area.

19. The electronic device of claim **18**, wherein the write frame is a frame where the data driver applies valid data signals to the display panel, and

wherein each of the j holding frames is a frame where the data driver applies bias data signals to the display panel.

20. The electronic device of claim **19**, wherein the active interval is overlapped with an uplink interval where the uplink signal is transmitted to the input sensor, and the inactive interval is not overlapped with the uplink interval.

21. The electronic device of claim **18**, wherein the first area and the second area differ in size from each other.

22. The electronic device of claim **18**, wherein the odd-numbered holding frame or the even-numbered holding frame among the j holding frames includes the active interval and the inactive interval.

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